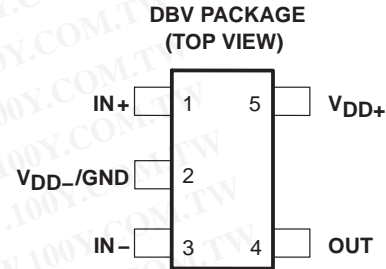


- **Output Swing Includes Both Supply Rails**
- **Low Noise . . . 21 nV/√Hz Typ at f = 1 kHz**
- **Low Input Bias Current . . . 1 pA Typ**
- **Very Low Power . . . 11 μA Per Channel Typ**
- **Common-Mode Input Voltage Range Includes Negative Rail**
- **Wide Supply Voltage Range 2.7 V to 10 V**
- **Available in the SOT-23 Package**
- **Macromodel Included**

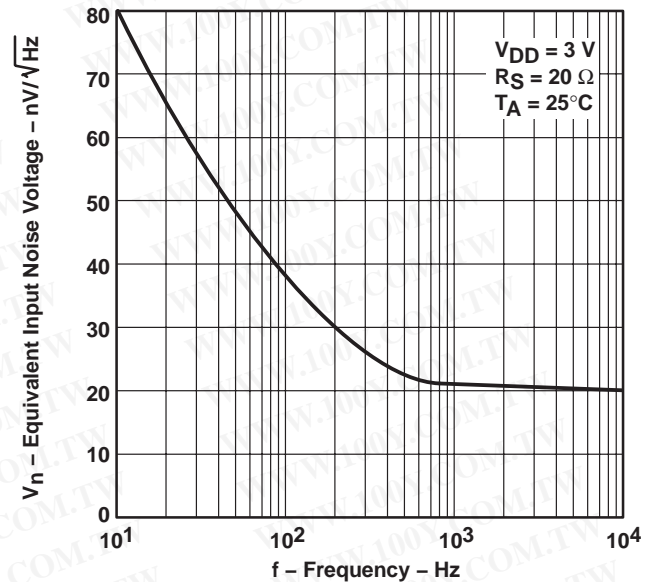
### description

The TLV2211 is a single low-voltage operational amplifier available in the SOT-23 package. It consumes only 11 μA (typ) of supply current and is ideal for battery-power applications. Looking at Figure 1, the TLV2211 has a 3-V noise level of 22 nV/√Hz at 1kHz; 5 times lower than competitive SOT-23 micropower solutions. The device exhibits rail-to-rail output performance for increased dynamic range in single- or split-supply applications. The TLV2211 is fully characterized at 3 V and 5 V and is optimized for low-voltage applications.

The TLV2211, exhibiting high input impedance and low noise, is excellent for small-signal conditioning for high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels combined with 3-V operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single or split supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs).



EQUIVALENT INPUT NOISE VOLTAGE†  
 VS  
 FREQUENCY



† All loads are referenced to 1.5 V.

Figure 1. Equivalent Input Noise Voltage Versus Frequency

### AVAILABLE OPTIONS

T <sub>A</sub>	V <sub>IOMax</sub> AT 25°C	PACKAGED DEVICES	SYMBOL	CHIP FORM‡ (Y)
		SOT-23 (DBV)†		
0°C to 70°C	3 mV	TLV2211CDBV	VACC	TLV2211Y
-40°C to 85°C	3 mV	TLV2211IDBV	VACI	

† The DBV package available in tape and reel only.

‡ Chip forms are tested at T<sub>A</sub> = 25°C only.



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# TLV2211, TLV2211Y

## Advanced LinCMOS™ RAIL-TO-RAIL

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#### description (continued)

With a total area of 5.6mm<sup>2</sup>, the SOT-23 package only requires one-third the board space of the standard 8-pin SOIC package. This ultra-small package allows designers to place single amplifiers very close to the signal source, minimizing noise pick-up from long PCB traces. TI has also taken special care to provide a pinout that is optimized for board layout (see Figure 2). Both inputs are separated by GND to prevent coupling or leakage paths. The OUT and IN– terminals are on the same end of the board to provide negative feedback. Finally, gain setting resistors and decoupling capacitor are easily placed around the package.

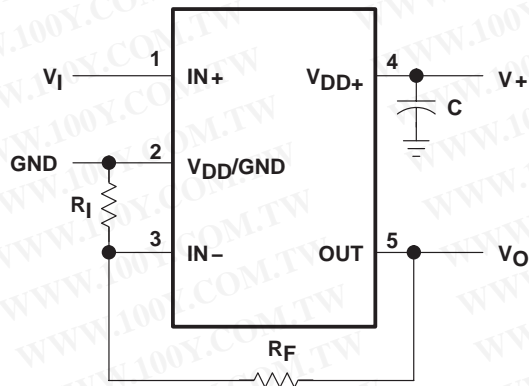


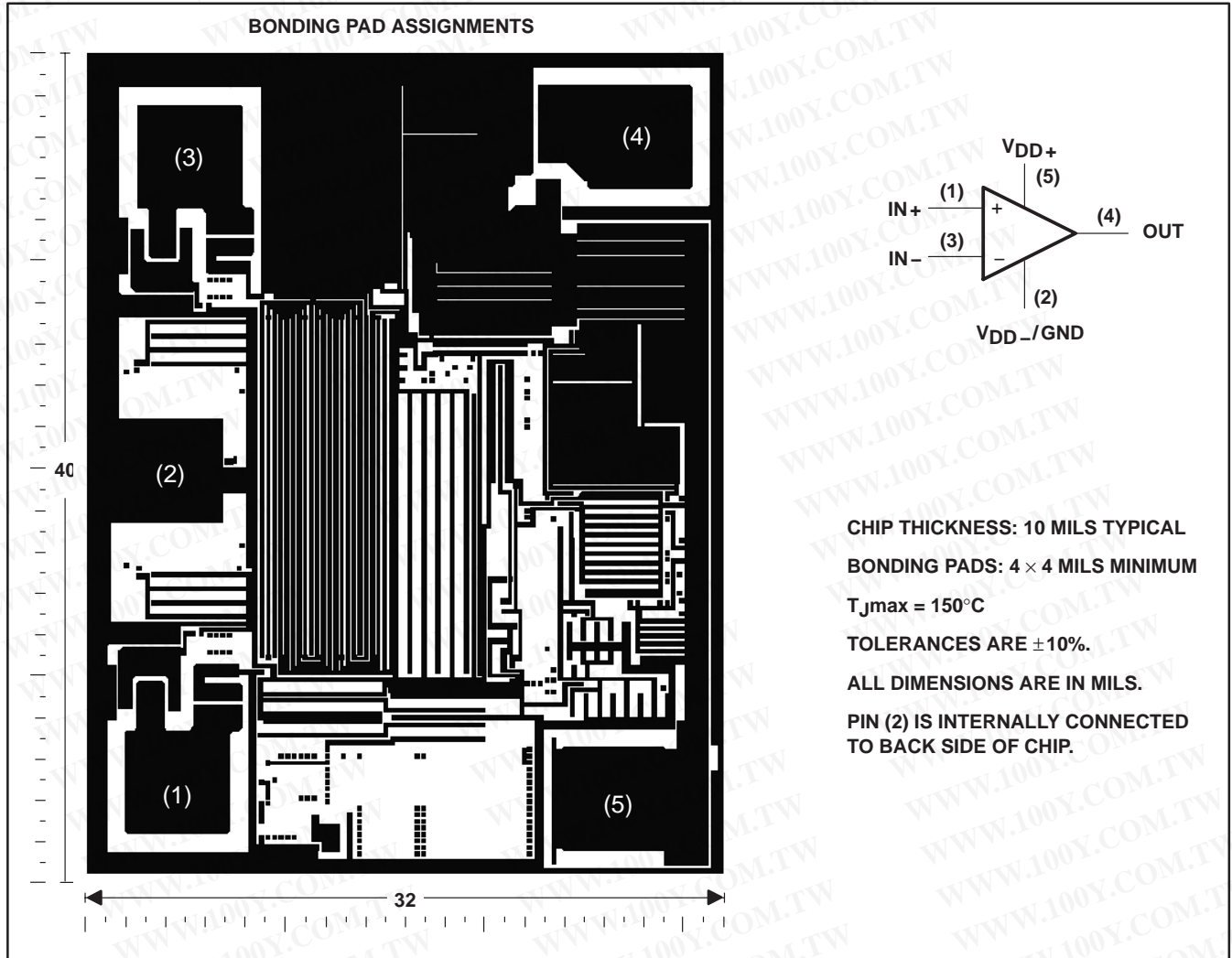
Figure 2. Typical Surface Mount Layout for a Fixed-Gain Noninverting Amplifier

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TLV2211Y chip information

This chip, when properly assembled, displays characteristics similar to the TLV2211C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. This chip may be mounted with conductive epoxy or a gold-silicon preform.



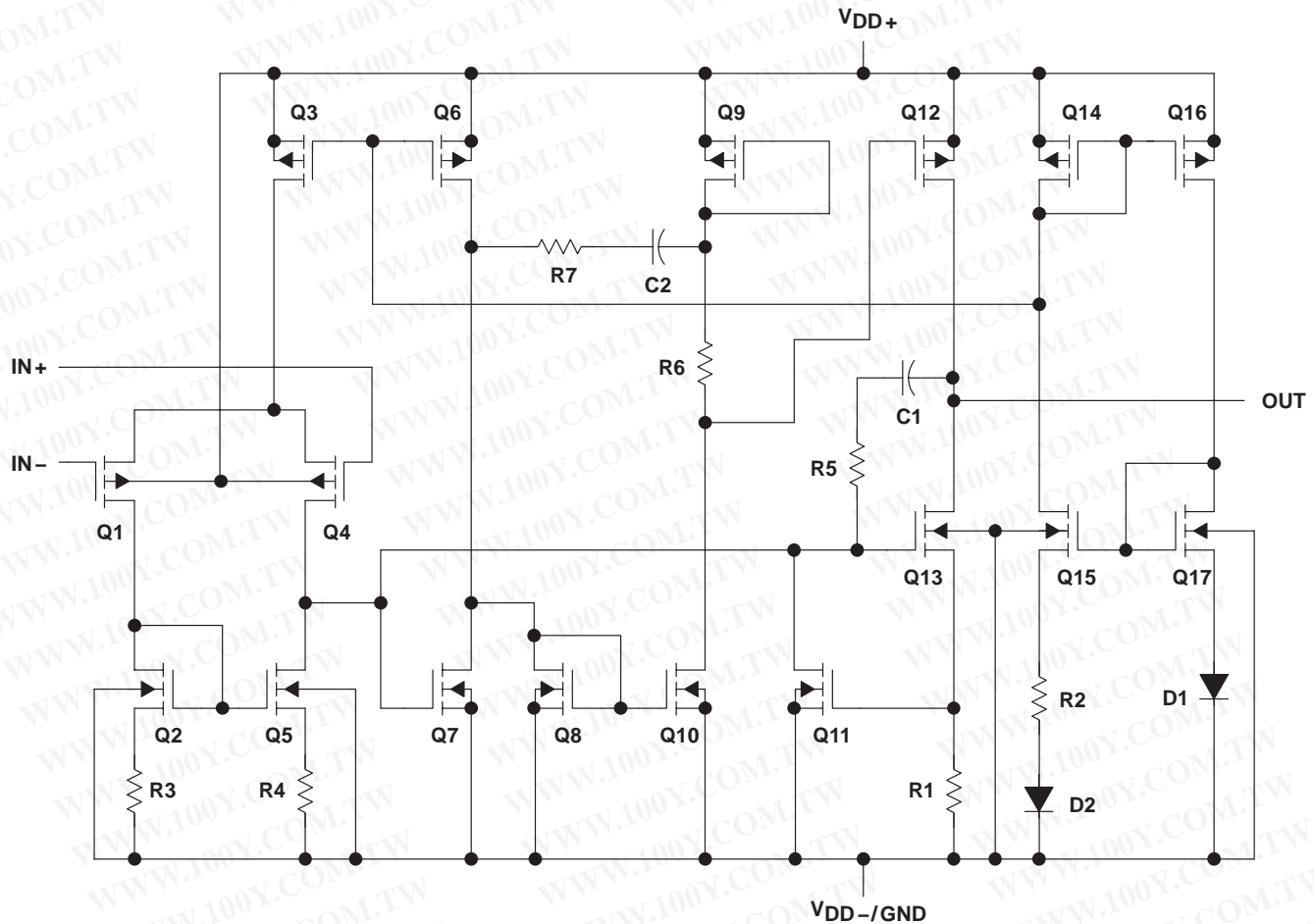
# TLV2211, TLV2211Y

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#### equivalent schematic



COMPONENT COUNT†	
Transistors	23
Diodes	6
Resistors	11
Capacitors	2

† Includes both amplifiers and all ESD, bias, and trim circuitry

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage, $V_{DD}$ (see Note 1)	12 V
Differential input voltage, $V_{ID}$ (see Note 2)	$\pm V_{DD}$
Input voltage range, $V_I$ (any input, see Note 1)	-0.3 V to $V_{DD}$
Input current, $I_I$ (each input)	$\pm 5$ mA
Output current, $I_O$	$\pm 50$ mA
Total current into $V_{DD+}$	$\pm 50$ mA
Total current out of $V_{DD-}$	$\pm 50$ mA
Duration of short-circuit current (at or below) 25°C (see Note 3)	unlimited
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, $T_A$ : TLV2211C	0°C to 70°C
TLV2211I	-40°C to 85°C
Storage temperature range, $T_{stg}$	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DBV package	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
- All voltage values, except differential voltages, are with respect to  $V_{DD-}$ .
  - Differential voltages are at the noninverting input with respect to the inverting input. Excessive current flows when input is brought below  $V_{DD-} - 0.3$  V.
  - The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
DBV	150 mW	1.2 mW/°C	96 mW	78 mW

**recommended operating conditions**

	TLV2211C		TLV2211I		UNIT
	MIN	MAX	MIN	MAX	
Supply voltage, $V_{DD}$ (see Note 1)	2.7	10	2.7	10	V
Input voltage range, $V_I$	$V_{DD-}$	$V_{DD+} - 1.3$	$V_{DD-}$	$V_{DD+} - 1.3$	V
Common-mode input voltage, $V_{IC}$	$V_{DD-}$	$V_{DD+} - 1.3$	$V_{DD-}$	$V_{DD+} - 1.3$	V
Operating free-air temperature, $T_A$	0	70	-40	85	°C

NOTE 1: All voltage values, except differential voltages, are with respect to  $V_{DD-}$ .



# TLV2211, TLV2211Y

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electrical characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2211C			TLV2211I			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_{IO}$ Input offset voltage	$V_{DD\pm} = \pm 1.5\text{ V}$ , $V_O = 0$ , $V_{IC} = 0$ , $R_S = 50\ \Omega$	Full range	0.47		3	0.47		3	mV
$\alpha_{VIO}$ Temperature coefficient of input offset voltage			1		1		$\mu\text{V}/^\circ\text{C}$		
Input offset voltage long-term drift (see Note 4)		25°C	0.003		0.003		$\mu\text{V}/\text{mo}$		
$I_{IO}$ Input offset current		Full range	0.5		60	0.5		60	pA
$I_{IB}$ Input bias current		Full range	1		60	1		60	pA
$V_{ICR}$ Common-mode input voltage range	$ V_{IO}  \leq 5\text{ mV}$ , $R_S = 50\ \Omega$	25°C	0 to 2	-0.3 to 2.2		0 to 2	-0.3 to 2.2	V	
		Full range	0 to 1.7		0 to 1.7				
$V_{OH}$ High-level output voltage	$I_{OH} = -100\ \mu\text{A}$ $I_{OH} = -250\ \mu\text{A}$	25°C	2.94		2.94		V		
		25°C	2.85		2.85				
		Full range	2.5		2.5				
$V_{OL}$ Low-level output voltage	$V_{IC} = 1.5\text{ V}$ , $I_{OL} = 50\ \mu\text{A}$ $V_{IC} = 1.5\text{ V}$ , $I_{OL} = 500\ \mu\text{A}$	25°C	15		15		mV		
		25°C	150		150				
		Full range	500		500				
$A_{VD}$ Large-signal differential voltage amplification	$V_{IC} = 1.5\text{ V}$ , $V_O = 1\text{ V to }2\text{ V}$	25°C	3	7	3	7	V/mV		
								Full range	1
		25°C	600		600				
$r_{i(d)}$ Differential input resistance		25°C	$10^{12}$		$10^{12}$		$\Omega$		
$r_{i(c)}$ Common-mode input resistance		25°C	$10^{12}$		$10^{12}$		$\Omega$		
$C_{i(c)}$ Common-mode input capacitance	$f = 10\text{ kHz}$	25°C	5		5		pF		
$Z_o$ Closed-loop output impedance	$f = 7\text{ kHz}$ , $A_V = 1$	25°C	200		200		$\Omega$		
CMRR Common-mode rejection ratio	$V_{IC} = 0\text{ to }1.7\text{ V}$ , $R_S = 50\ \Omega$ , $V_O = 1.5\text{ V}$	25°C	65	83	65	83	dB		
		Full range	60		60				
$k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{DD} / \Delta V_{IO}$ )	$V_{DD} = 2.7\text{ V to }8\text{ V}$ , No load, $V_{IC} = V_{DD}/2$	25°C	80	95	80	95	dB		
		Full range	80		80				
$I_{DD}$ Supply current	$V_O = 1.5\text{ V}$ , No load	25°C	11	25	11	25	$\mu\text{A}$		
		Full range	30		30				

† Full range for the TLV2211C is 0°C to 70°C. Full range for the TLV2211I is -40°C to 85°C.

‡ Referenced to 1.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.



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operating characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2211C			TLV2211I			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain $V_O = 1.1\text{ V to }1.9\text{ V}$ , $R_L = 10\text{ k}\Omega$ ‡, $C_L = 100\text{ pF}$ ‡	25°C	0.01	0.025		0.01	0.025		V/ $\mu$ s
		Full range	0.005			0.005			
$V_n$	Equivalent input noise voltage $f = 10\text{ Hz}$ $f = 1\text{ kHz}$	25°C	80			80			nV/ $\sqrt{\text{Hz}}$
		25°C	22			22			
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage $f = 0.1\text{ Hz to }1\text{ Hz}$ $f = 0.1\text{ Hz to }10\text{ Hz}$	25°C	660			660			nV
		25°C	880			880			
$I_n$	Equivalent input noise current	25°C	0.6			0.6			fA/ $\sqrt{\text{Hz}}$
	Gain-bandwidth product $f = 10\text{ kHz}$ , $R_L = 10\text{ k}\Omega$ ‡, $C_L = 100\text{ pF}$ ‡	25°C	56			56			kHz
BOM	Maximum output-swing bandwidth $V_{O(PP)} = 1\text{ V}$ , $R_L = 10\text{ k}\Omega$ ‡, $A_V = 1$ , $C_L = 100\text{ pF}$ ‡	25°C	7			7			kHz
$\phi_m$	Phase margin at unity gain $R_L = 10\text{ k}\Omega$ ‡, $C_L = 100\text{ pF}$ ‡	25°C	56°			56°			
		25°C	20			20			dB

† Full range is  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

‡ Referenced to 1.5 V

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electrical characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2211C			TLV2211I			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_{IO}$ Input offset voltage			0.45 3			0.45 3			mV
$\alpha_{VIO}$ Temperature coefficient of input offset voltage		Full range	0.5			0.5			$\mu\text{V}/^\circ\text{C}$
Input offset voltage long-term drift (see Note 5)	$V_{DD\pm} = \pm 2.5\text{ V}$ , $V_O = 0$ ,	$V_{IC} = 0$ , $R_S = 50\ \Omega$	25°C	0.003		0.003		$\mu\text{V}/\text{mo}$	
$I_{IO}$ Input offset current			25°C	0.5	60	0.5	60	pA	
			Full range	150		150			
$I_{IB}$ Input bias current			25°C	1	60	1	60	pA	
			Full range	150		150			
$V_{ICR}$ Common-mode input voltage range	$ V_{IO}  \leq 5\text{ mV}$	$R_S = 50\ \Omega$	25°C	0 to 4	-0.3 to 4.2	0 to 4	-0.3 to 4.2	V	
			Full range	0 to 3.5	0 to 3.5	0 to 3.5	0 to 3.5		
$V_{OH}$ High-level output voltage	$I_{OH} = -100\ \mu\text{A}$		25°C	4.95		4.95		V	
			25°C	4.875		4.875			
			Full range	4.5		4.5			
$V_{OL}$ Low-level output voltage	$V_{IC} = 2.5\text{ V}$ , $V_O = 0$	$I_{OL} = 50\ \mu\text{A}$	25°C	12		12		mV	
			25°C	120		120			
			Full range	500		500			
$A_{VD}$ Large-signal differential voltage amplification	$V_{IC} = 2.5\text{ V}$ , $V_O = 1\text{ V to }4\text{ V}$	$R_L = 10\ \text{k}\Omega$ ‡	25°C	6	12	6	12	V/mV	
			Full range	3		3			
			$R_L = 1\ \text{M}\Omega$ ‡	25°C	800		800		
$r_{i(d)}$ Differential input resistance			25°C	1012		1012		$\Omega$	
$r_{i(c)}$ Common-mode input resistance			25°C	1012		1012		$\Omega$	
$C_{i(c)}$ Common-mode input capacitance	$f = 10\ \text{kHz}$ ,		25°C	5		5		pF	
$z_o$ Closed-loop output impedance	$f = 7\ \text{kHz}$ ,	$A_V = 1$	25°C	200		200		$\Omega$	
CMRR Common-mode rejection ratio	$V_{IC} = 0\text{ to }2.7\text{ V}$ , $R_S = 50\ \Omega$	$V_O = 2.5\text{ V}$ ,	25°C	70	83	70	83	dB	
			Full range	70		70			
$k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{DD} / \Delta V_{IO}$ )	$V_{DD} = 4.4\text{ V to }8\text{ V}$ , No load	$V_{IC} = V_{DD}/2$ ,	25°C	80	95	80	95	dB	
			Full range	80		80			
$I_{DD}$ Supply current	$V_O = 2.5\text{ V}$ ,	No load	25°C	13	25	13	25	$\mu\text{A}$	
			Full range	30		30			

† Full range for the TLV2211C is 0°C to 70°C. Full range for the TLV2211I is -40°C to 85°C.

‡ Referenced to 1.5 V

NOTE 5: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.





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**operating characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2211C			TLV2211I			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain $V_O = 1.5\text{ V to }3.5\text{ V}$ , $R_L = 10\text{ k}\Omega$ ‡, $C_L = 100\text{ pF}$ ‡	25°C	0.01	0.025		0.01	0.025		V/ $\mu$ s
		Full range	0.005			0.005			
$V_n$	Equivalent input noise voltage	f = 10 Hz	72			72			nV/ $\sqrt{\text{Hz}}$
		f = 1 kHz	21			21			
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz	600			600			nV
		f = 0.1 Hz to 10 Hz	800			800			
$I_n$	Equivalent input noise current	25°C	0.6			0.6			fA/ $\sqrt{\text{Hz}}$
	Gain-bandwidth product	f = 10 kHz, $C_L = 100\text{ pF}$ ‡	$R_L = 10\text{ k}\Omega$ ‡,	25°C		65		65	kHz
BOM	Maximum output-swing bandwidth	$V_{O(PP)} = 2\text{ V}$ , $R_L = 10\text{ k}\Omega$ ‡,	$A_V = 1$ , $C_L = 100\text{ pF}$ ‡	25°C		7		7	kHz
$\phi_m$	Phase margin at unity gain	$R_L = 10\text{ k}\Omega$ ‡,	$C_L = 100\text{ pF}$ ‡	25°C		56°		56°	
				25°C		22		22	dB
	Gain margin			25°C		22		22	dB

† Full range is  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

‡ Referenced to 1.5 V

**electrical characteristics at  $V_{DD} = 3\text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	TLV2211Y			UNIT	
		MIN	TYP	MAX		
$V_{IO}$	Input offset voltage	0.47			mV	
$I_{IO}$	Input offset current	0.5			60	
$I_{IB}$	Input bias current	1			60	
$V_{ICR}$	Common-mode input voltage range	-0.3 to 2.2			V	
$V_{OH}$	High-level output voltage	$I_{OH} = -100\text{ }\mu\text{A}$			2.94	
		$I_{OH} = -200\text{ }\mu\text{A}$			2.85	
$V_{OL}$	Low-level output voltage	$V_{IC} = 0$ , $I_{OL} = 50\text{ }\mu\text{A}$			15	
		$V_{IC} = 0$ , $I_{OL} = 500\text{ }\mu\text{A}$			150	
$A_{VD}$	Large-signal differential voltage amplification	$V_{IC} = 1.5\text{ V}$ , $V_O = 1\text{ V to }2\text{ V}$	$R_L = 10\text{ k}\Omega$ †	7		V/mV
			$R_L = 1\text{ M}\Omega$ †	600		
$r_{i(d)}$	Differential input resistance	$10^{12}$			$\Omega$	
$r_{i(c)}$	Common-mode input resistance	$10^{12}$			$\Omega$	
$c_{i(c)}$	Common-mode input capacitance	f = 10 kHz			5	
$z_o$	Closed-loop output impedance	f = 7 kHz,	$A_V = 1$		200	
CMRR	Common-mode rejection ratio	$V_{IC} = 0\text{ to }1.7\text{ V}$ ,	$V_O = 1.5\text{ V}$ ,	$R_S = 50\text{ }\Omega$		83
$k_{SVR}$	Supply voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ )	$V_{DD} = 2.7\text{ V to }8\text{ V}$ ,	$V_{IC} = V_{DD}/2$ ,	No load		95
$I_{DD}$	Supply current	$V_O = 1.5\text{ V}$ ,	No load		11	

† Referenced to 1.5 V

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electrical characteristics at  $V_{DD} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS	TLV2211Y			UNIT
		MIN	TYP	MAX	
$V_{IO}$ Input offset voltage	$V_{DD} \pm \pm 2.5\text{ V}$ , $R_S = 50\ \Omega$ , $V_{IC} = 0$ , $V_O = 0$	0.45			mV
$I_{IO}$ Input offset current		0.5 60			pA
$I_{IB}$ Input bias current		1 60			pA
$V_{ICR}$ Common-mode input voltage range	$ V_{IO}  \leq 5\text{ mV}$ , $R_S = 50\ \Omega$	-0.3 to 4.2			V
$V_{OH}$ High-level output voltage	$I_{OH} = -100\ \mu\text{A}$	4.95			V
	$I_{OH} = -250\ \mu\text{A}$	4.875			
$V_{OL}$ Low-level output voltage	$V_{IC} = 2.5\text{ V}$ , $I_{OL} = 50\ \mu\text{A}$	12			mV
	$V_{IC} = 2.5\text{ V}$ , $I_{OL} = 500\ \mu\text{A}$	120			
$A_{VD}$ Large-signal differential voltage amplification	$V_{IC} = 2.5\text{ V}$ , $V_O = 1\text{ V to }4\text{ V}$	$R_L = 10\text{ k}\Omega^\dagger$	12		V/mV
		$R_L = 1\text{ M}\Omega^\dagger$	800		
$r_{i(d)}$ Differential input resistance		$10^{12}$			$\Omega$
$r_{i(c)}$ Common-mode input resistance		$10^{12}$			$\Omega$
$c_{i(c)}$ Common-mode input capacitance	$f = 10\text{ kHz}$	5			pF
$z_o$ Closed-loop output impedance	$f = 7\text{ kHz}$ , $A_V = 1$	200			$\Omega$
CMRR Common-mode rejection ratio	$V_{IC} = 0\text{ to }2.7\text{ V}$ , $V_O = 2.5\text{ V}$ , $R_S = 50\ \Omega$	83			dB
$k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ )	$V_{DD} = 4.4\text{ V to }8\text{ V}$ , $V_{IC} = V_{DD}/2$ , No load	95			dB
$I_{DD}$ Supply current	$V_O = 2.5\text{ V}$ , No load	13			$\mu\text{A}$

$^\dagger$  Referenced to 1.5 V

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**TYPICAL CHARACTERISTICS**

**Table of Graphs**

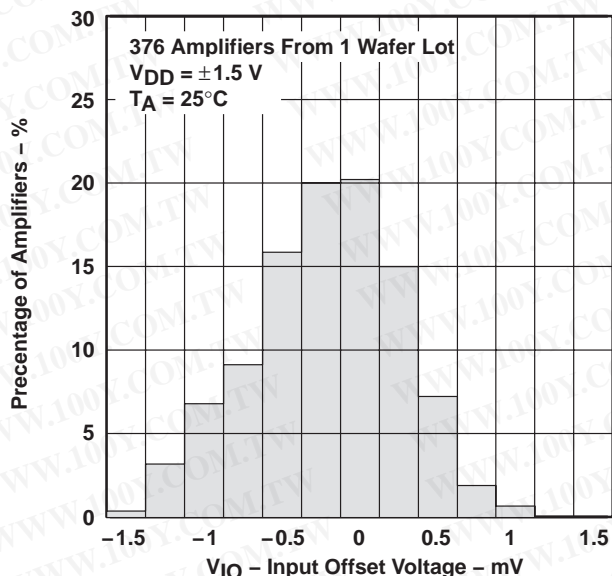
		<b>FIGURE</b>
$V_{IO}$	Input offset voltage	Distribution vs Common-mode input voltage
		3, 4 5, 6
$\alpha_{VIO}$	Input offset voltage temperature coefficient	Distribution
		7, 8
$I_{IB}/I_{IO}$	Input bias and input offset currents	vs Free-air temperature
		9
$V_I$	Input voltage	vs Supply voltage vs Free-air temperature
		10 11
$V_{OH}$	High-level output voltage	vs High-level output current
		12, 15
$V_{OL}$	Low-level output voltage	vs Low-level output current
		13, 14, 16
$V_{O(PP)}$	Maximum peak-to-peak output voltage	vs Frequency
		17
$I_{OS}$	Short-circuit output current	vs Supply voltage vs Free-air temperature
		18 19
$V_O$	Output voltage	vs Differential input voltage
		20, 21
$A_{VD}$	Differential voltage amplification	vs Load resistance vs Frequency vs Free-air temperature
		22 23, 24 25, 26
$z_o$	Output impedance	vs Frequency
		27, 28
CMRR	Common-mode rejection ratio	vs Frequency vs Free-air temperature
		29 30
$k_{SVR}$	Supply-voltage rejection ratio	vs Frequency vs Free-air temperature
		31, 32 33
$I_{DD}$	Supply current	vs Supply voltage
		34
SR	Slew rate	vs Load capacitance vs Free-air temperature
		35 36
$V_O$	Large-signal pulse response	vs Time
		37, 38, 39, 40
$V_O$	Small-signal pulse response	vs Time
		41, 42, 43, 44
$V_n$	Equivalent input noise voltage	vs Frequency
		45, 46
	Noise voltage (referred to input)	Over a 10-second period
		47
THD + N	Total harmonic distortion plus noise	vs Frequency
		48
	Gain-bandwidth product	vs Free-air temperature vs Supply voltage
		49 50
$\phi_m$	Phase margin	vs Frequency vs Load capacitance
		23, 24 51
	Gain margin	vs Load capacitance
		52
$B_1$	Unity-gain bandwidth	vs Load capacitance
		53

**TLV2211, TLV2211Y**  
**Advanced LinCMOS™ RAIL-TO-RAIL**  
**MICROPOWER SINGLE OPERATIONAL AMPLIFIERS**

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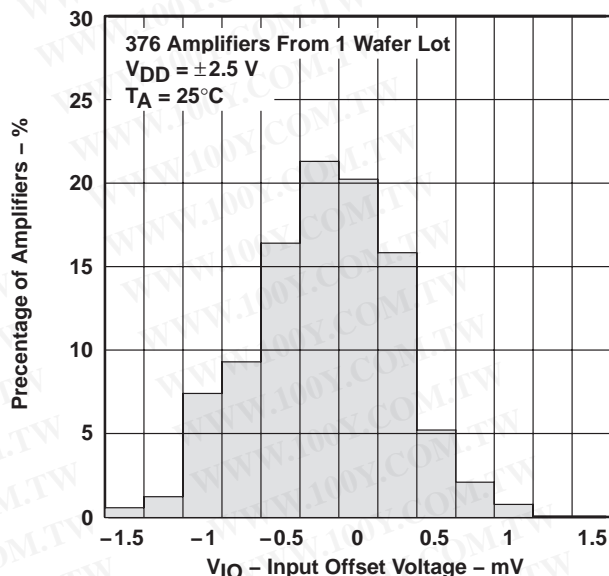
**TYPICAL CHARACTERISTICS**

**DISTRIBUTION OF TLV2211  
 INPUT OFFSET VOLTAGE**



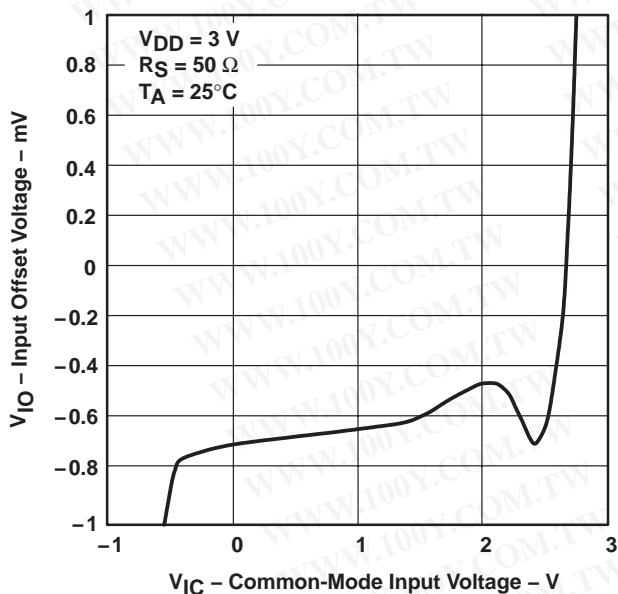
**Figure 3**

**DISTRIBUTION OF TLV2211  
 INPUT OFFSET VOLTAGE**



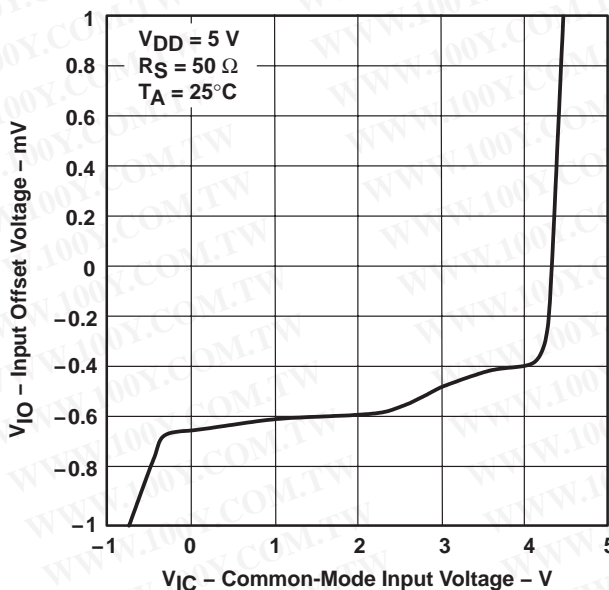
**Figure 4**

**INPUT OFFSET VOLTAGE†  
 vs  
 COMMON-MODE INPUT VOLTAGE**



**Figure 5**

**INPUT OFFSET VOLTAGE†  
 vs  
 COMMON-MODE INPUT VOLTAGE**



**Figure 6**

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.



TYPICAL CHARACTERISTICS

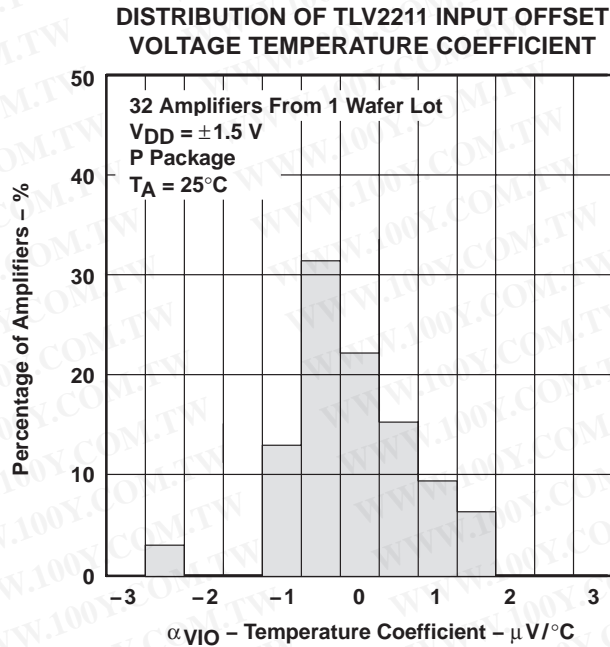


Figure 7

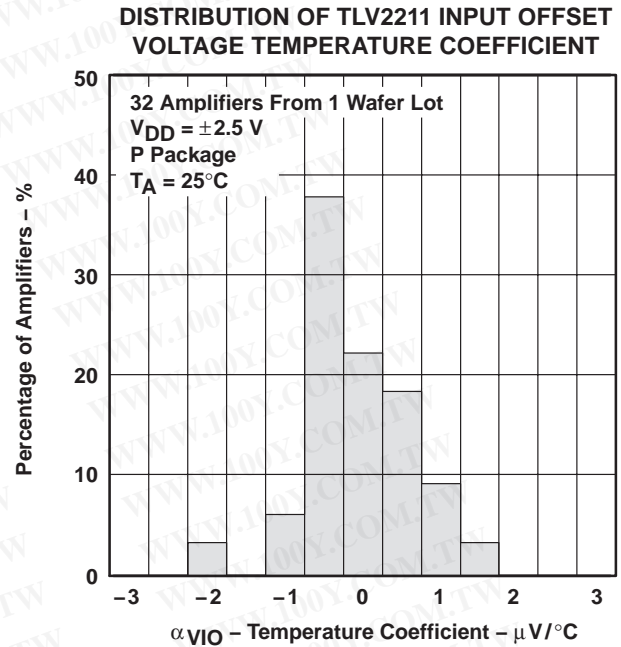


Figure 8

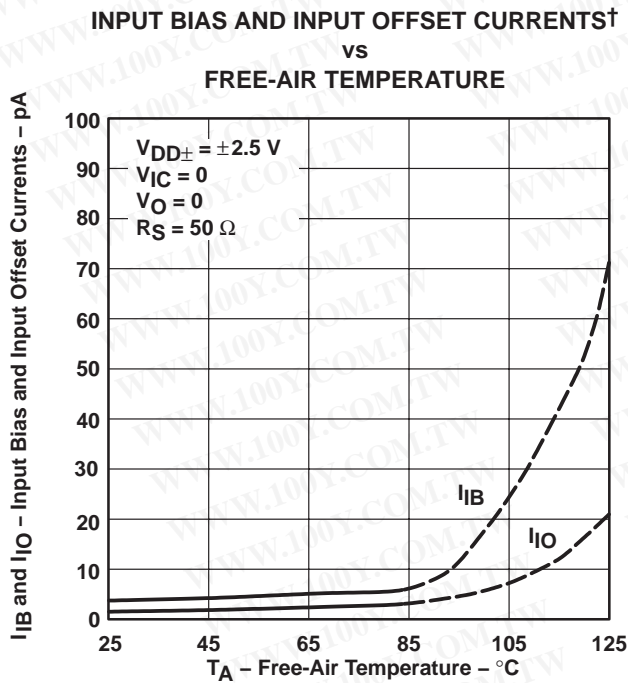


Figure 9

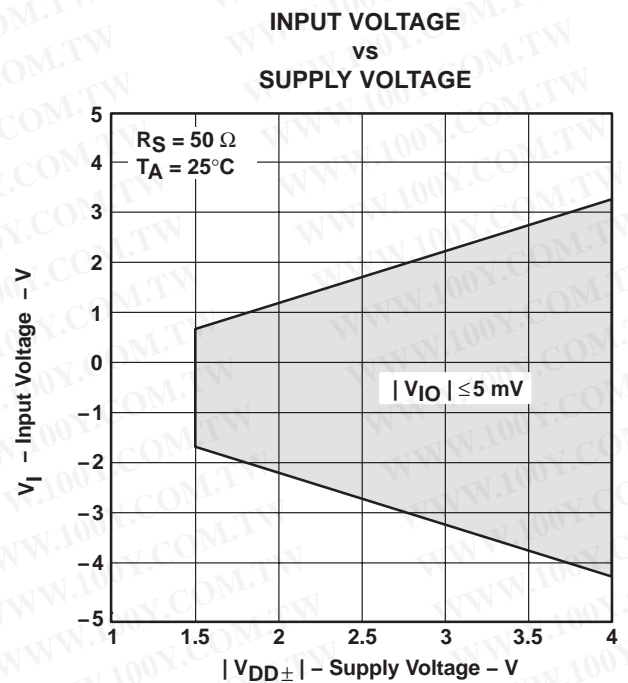
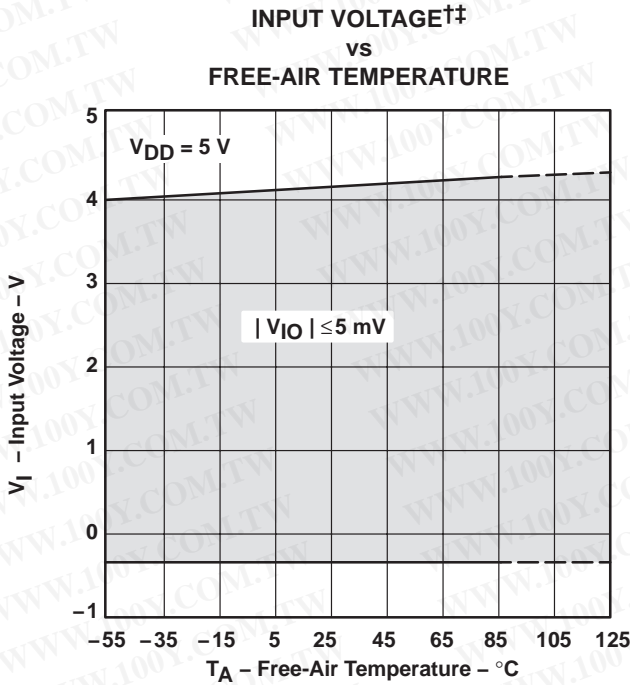


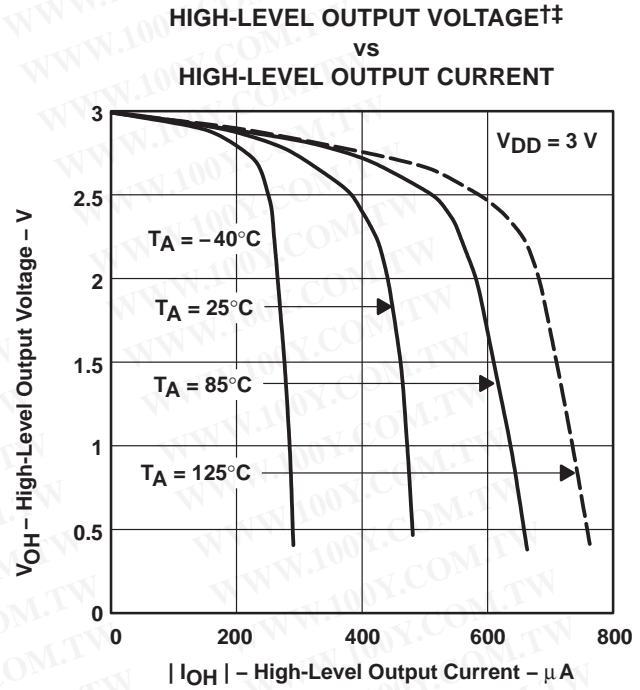
Figure 10

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

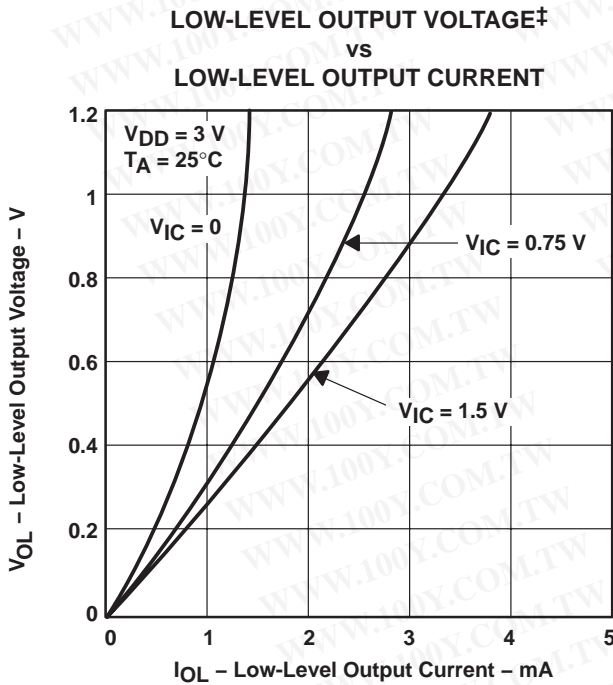
**TYPICAL CHARACTERISTICS**



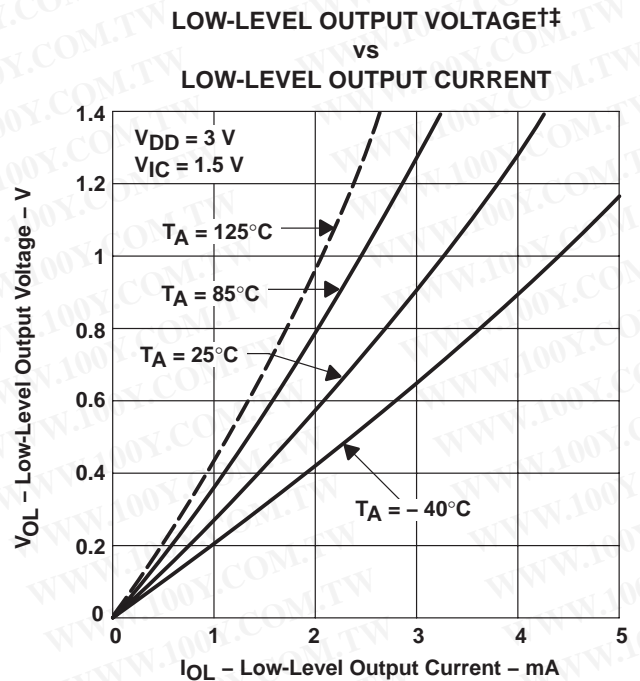
**Figure 11**



**Figure 12**



**Figure 13**



**Figure 14**

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.  
 ‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

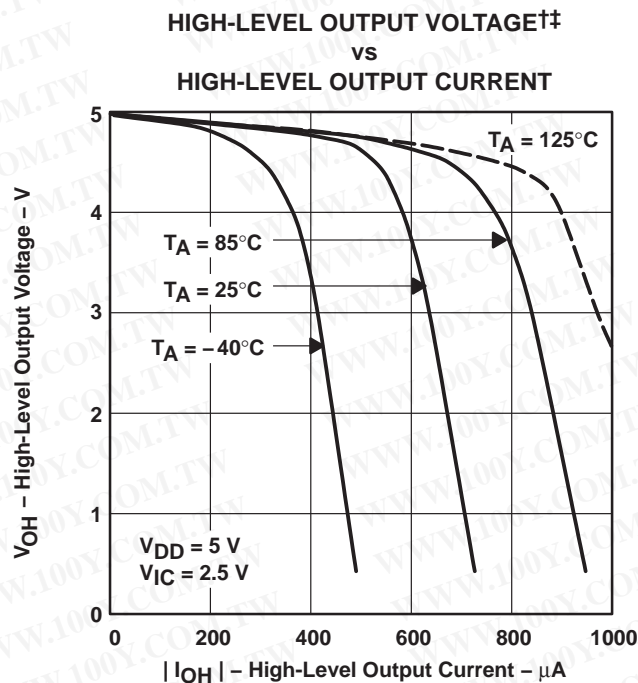


Figure 15

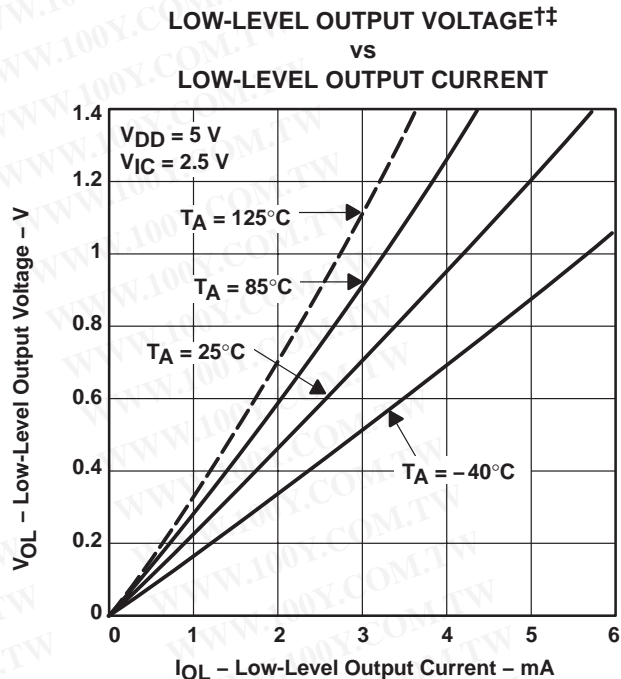


Figure 16

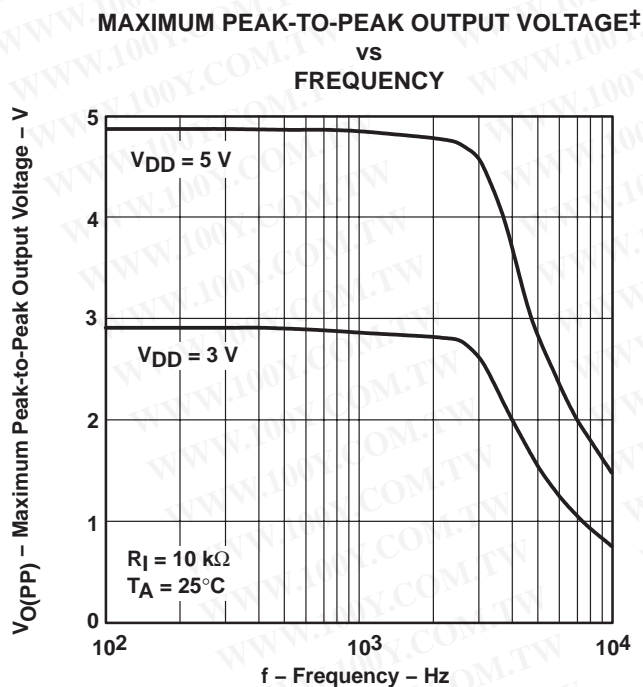


Figure 17

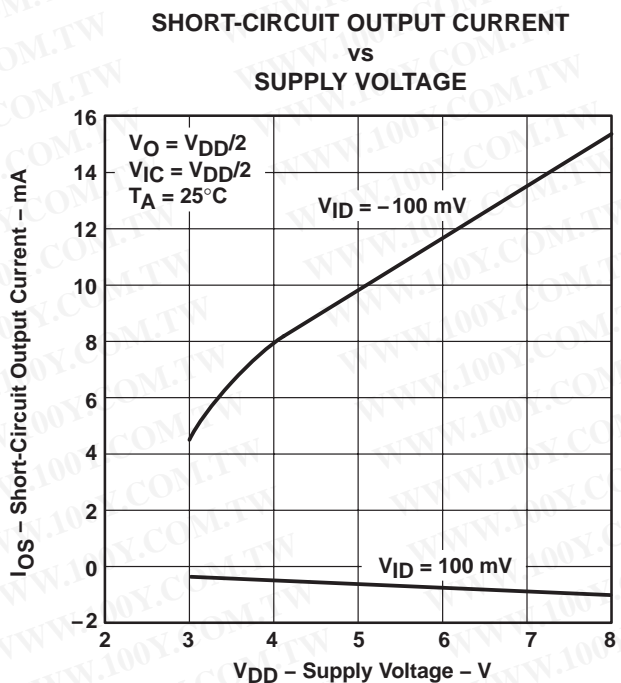


Figure 18

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.  
 ‡ For all curves where  $V_{DD} = 5 V$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3 V$ , all loads are referenced to 1.5 V.

# TLV2211, TLV2211Y

## Advanced LinCMOS™ RAIL-TO-RAIL

### MICROPOWER SINGLE OPERATIONAL AMPLIFIERS

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#### TYPICAL CHARACTERISTICS

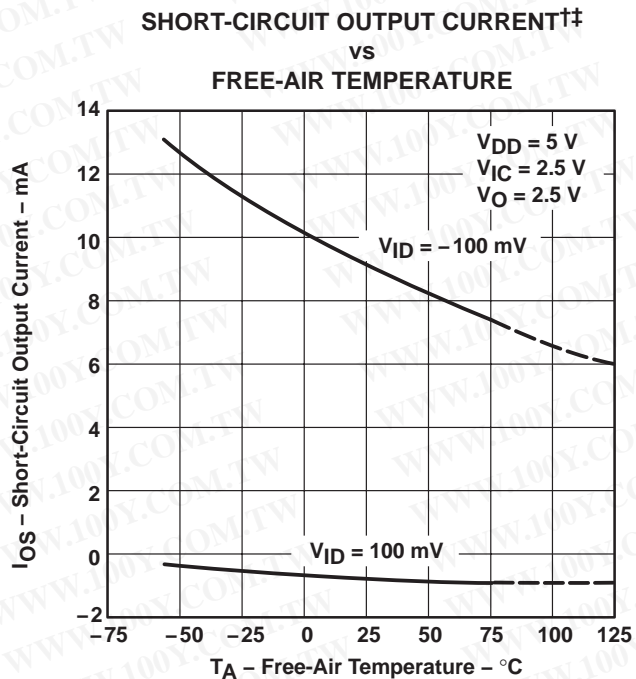


Figure 19

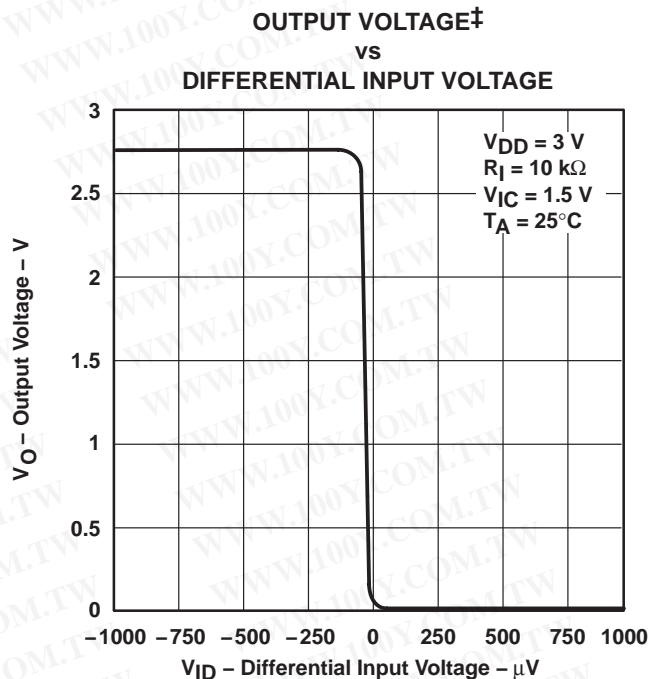


Figure 20

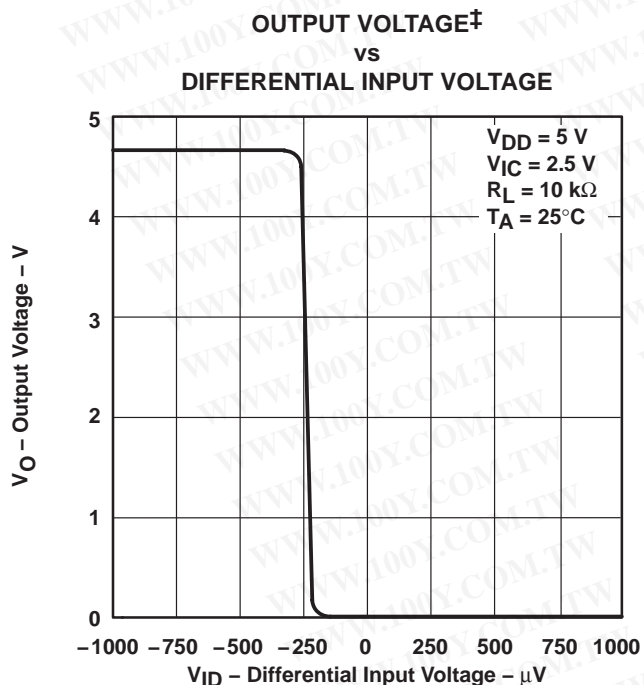


Figure 21

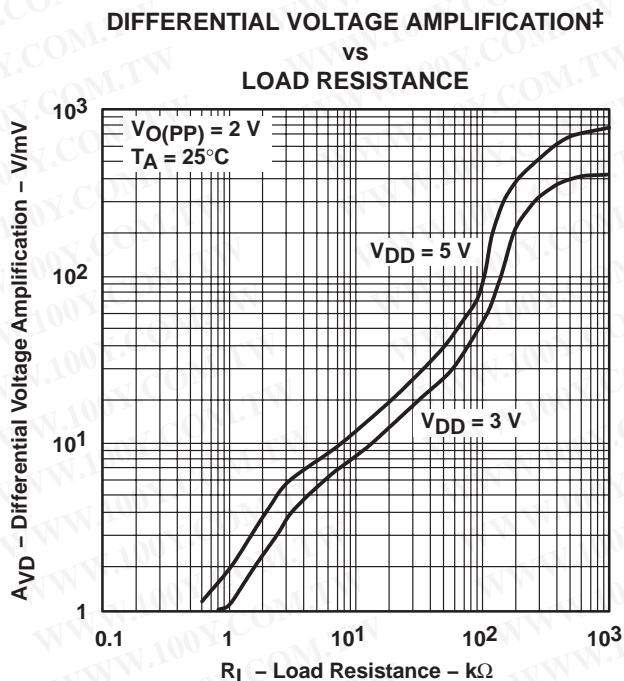


Figure 22

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.



TYPICAL CHARACTERISTICS

LARGE-SIGNAL DIFFERENTIAL VOLTAGE  
 AMPLIFICATION AND PHASE MARGIN†  
 vs  
 FREQUENCY

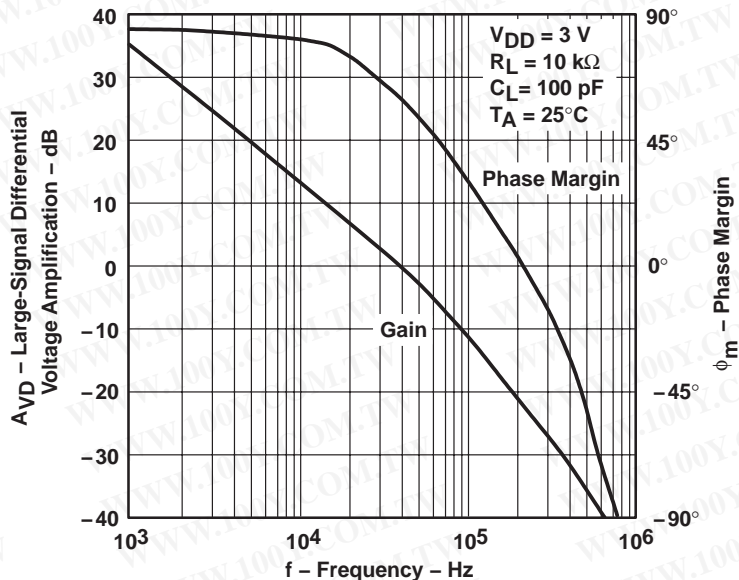


Figure 23

LARGE-SIGNAL DIFFERENTIAL VOLTAGE  
 AMPLIFICATION AND PHASE MARGIN†  
 vs  
 FREQUENCY

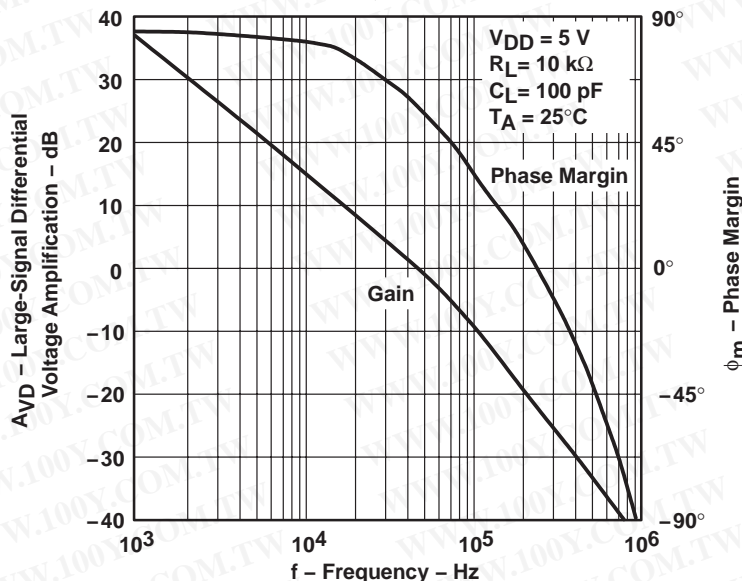
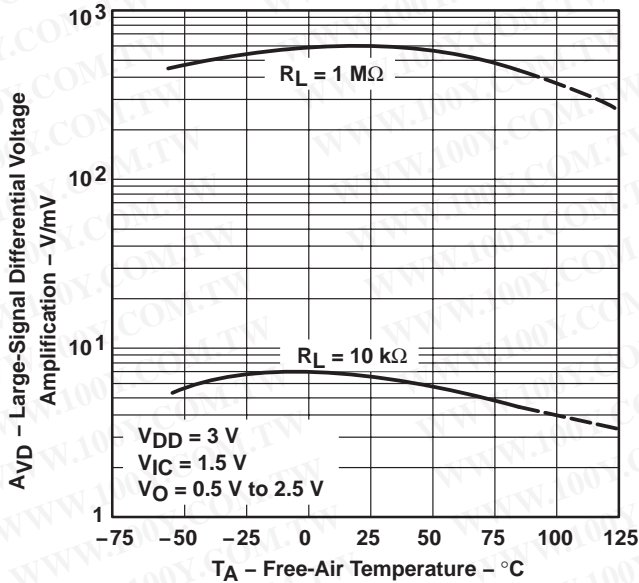


Figure 24

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

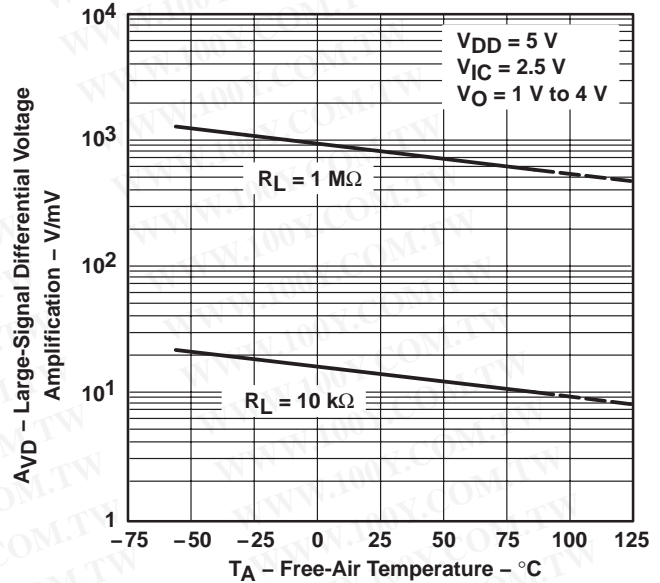
**TYPICAL CHARACTERISTICS**

**LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION†‡**  
 vs  
**FREE-AIR TEMPERATURE**



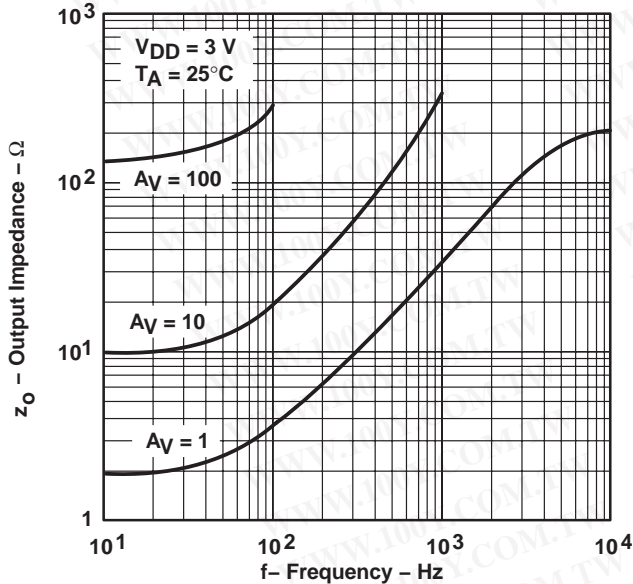
**Figure 25**

**LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION†‡**  
 vs  
**FREE-AIR TEMPERATURE**



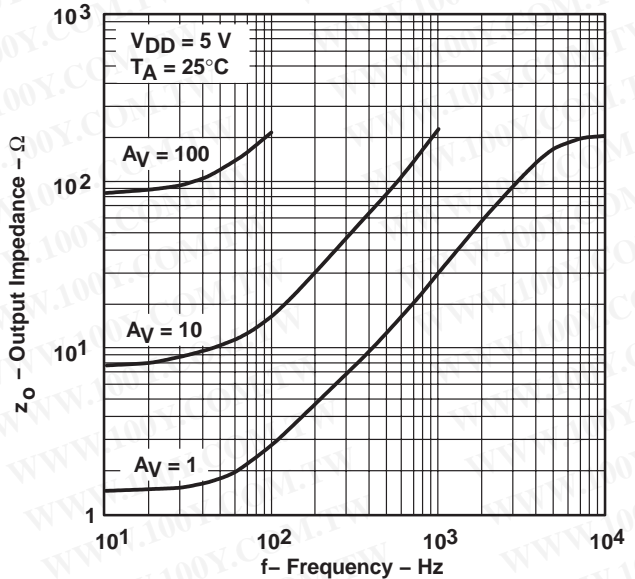
**Figure 26**

**OUTPUT IMPEDANCE‡**  
 vs  
**FREQUENCY**



**Figure 27**

**OUTPUT IMPEDANCE‡**  
 vs  
**FREQUENCY**



**Figure 28**

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.  
 ‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

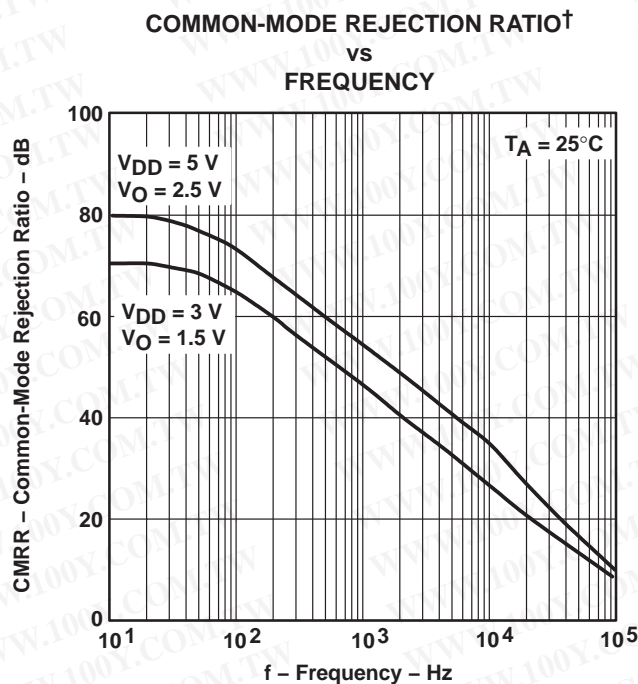


Figure 29

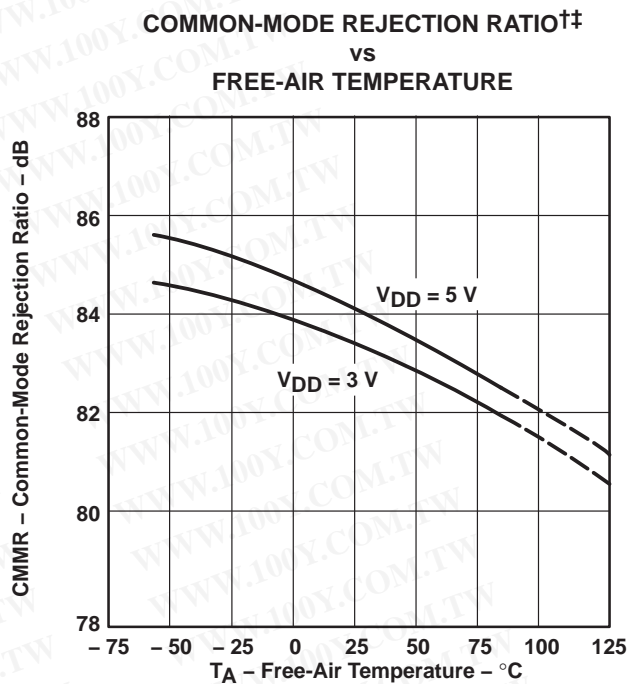


Figure 30

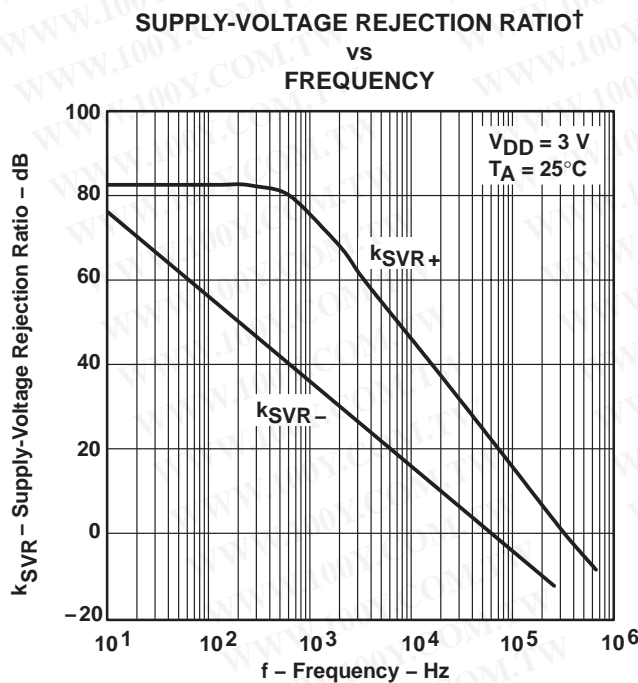


Figure 31

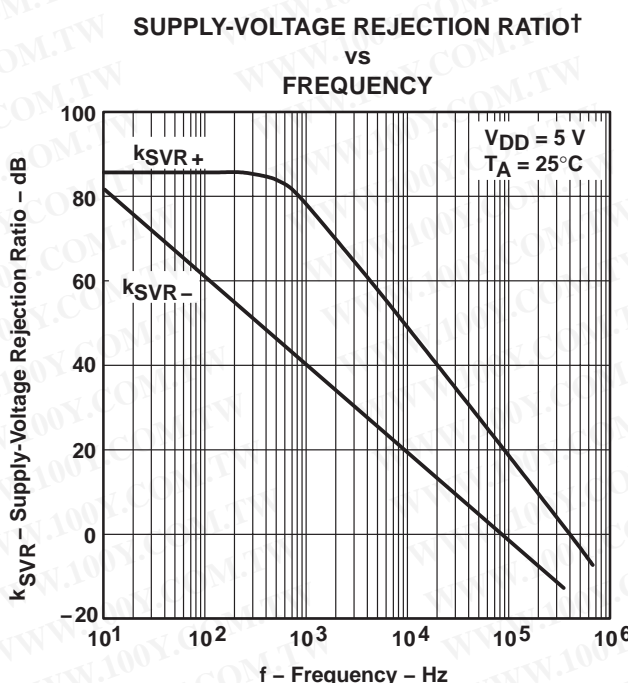


Figure 32

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.  
 †† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

# TLV2211, TLV2211Y

## Advanced LinCMOS™ RAIL-TO-RAIL

### MICROPOWER SINGLE OPERATIONAL AMPLIFIERS

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#### TYPICAL CHARACTERISTICS

**SUPPLY-VOLTAGE REJECTION RATIO†**  
vs  
**FREE-AIR TEMPERATURE**

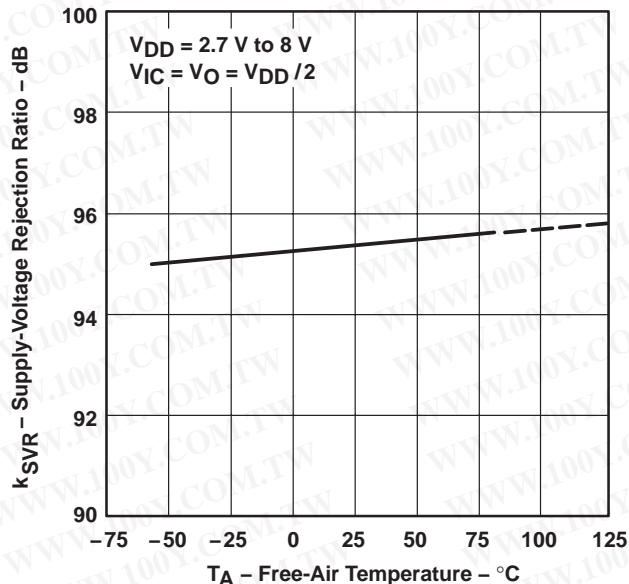


Figure 33

**SUPPLY CURRENT†**  
vs  
**SUPPLY VOLTAGE**

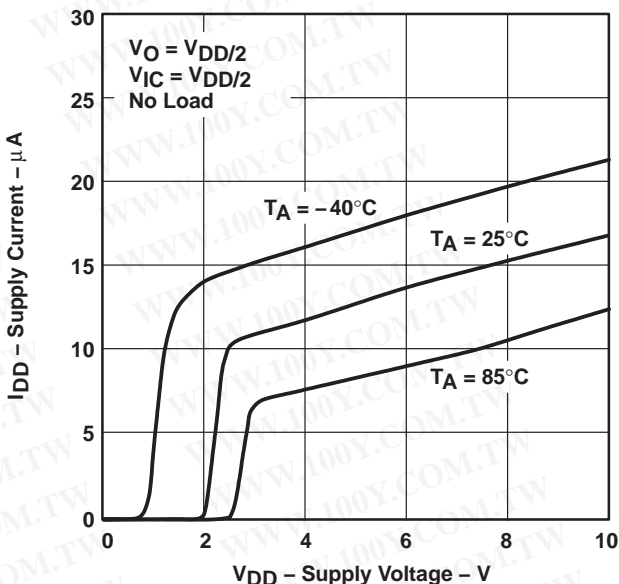


Figure 34

**SLEW RATE‡**  
vs  
**LOAD CAPACITANCE**

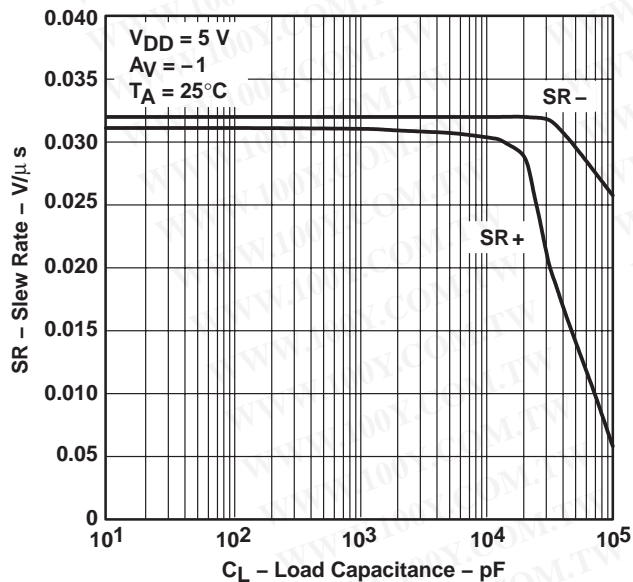


Figure 35

**SLEW RATE‡**  
vs  
**FREE-AIR TEMPERATURE**

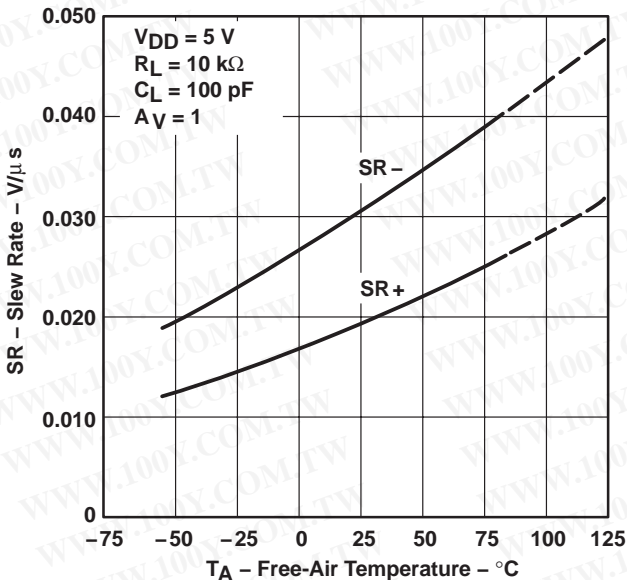


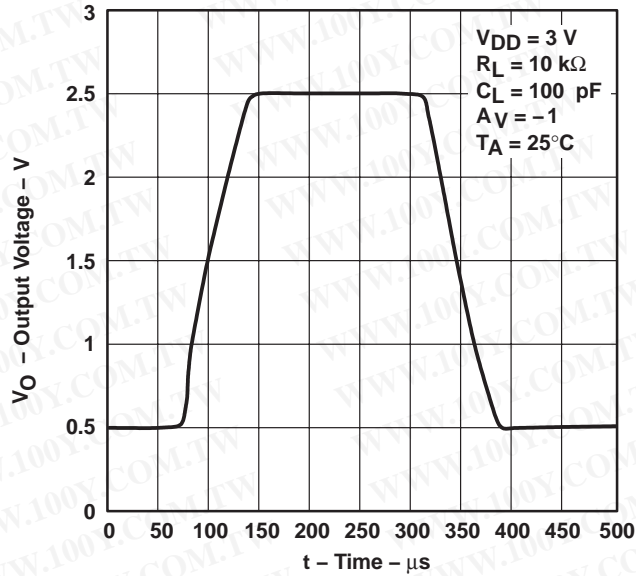
Figure 36

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

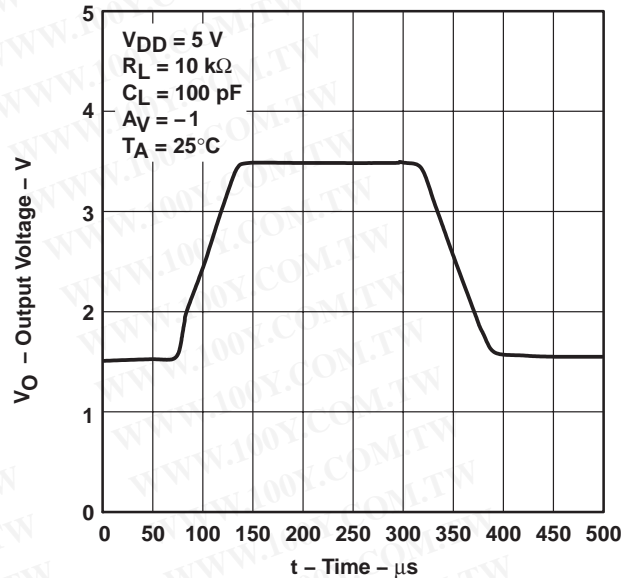
**TYPICAL CHARACTERISTICS**

**INVERTING LARGE-SIGNAL PULSE RESPONSE†**



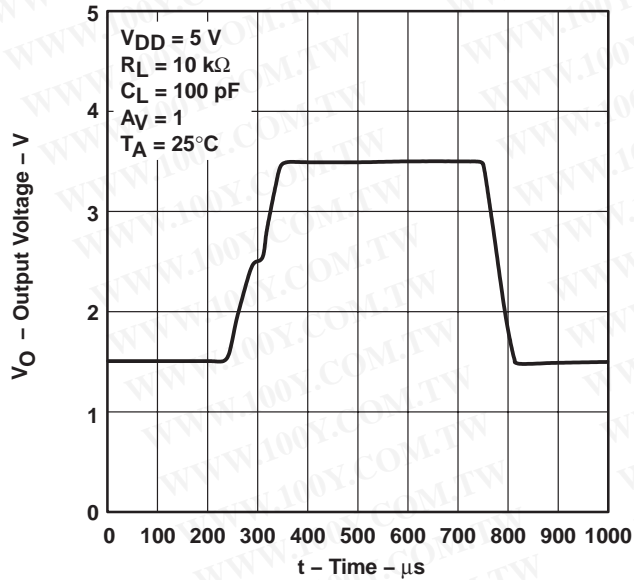
**Figure 37**

**INVERTING LARGE-SIGNAL PULSE RESPONSE†**



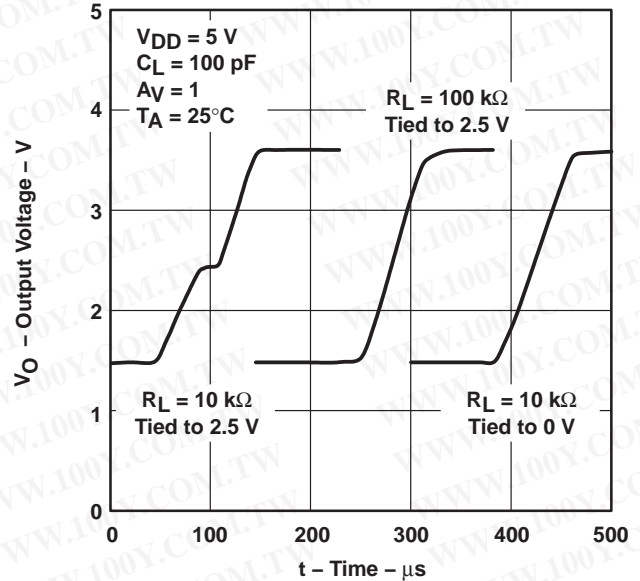
**Figure 38**

**VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE†**



**Figure 39**

**VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE†**



**Figure 40**

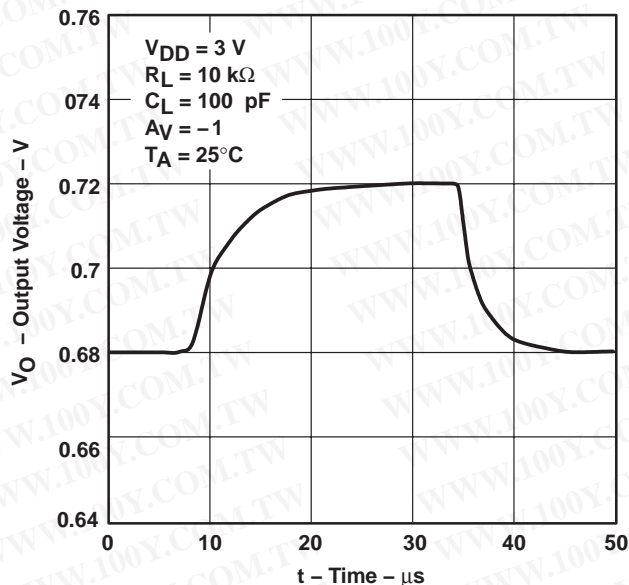
† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

**TLV2211, TLV2211Y**  
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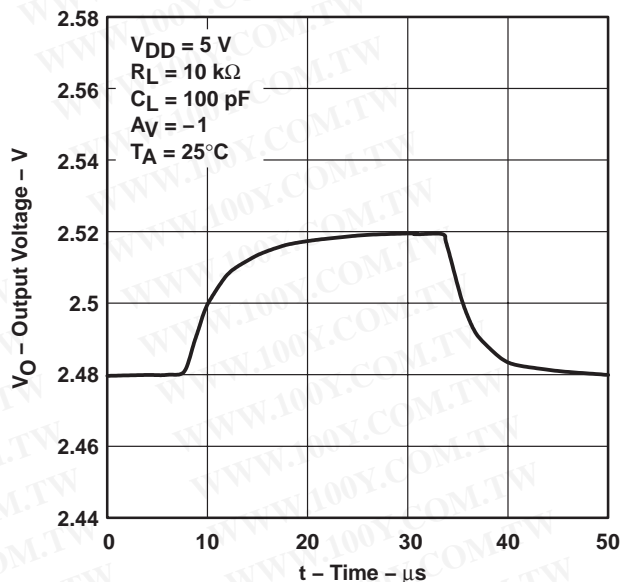
**TYPICAL CHARACTERISTICS**

**INVERTING SMALL-SIGNAL PULSE RESPONSE†**



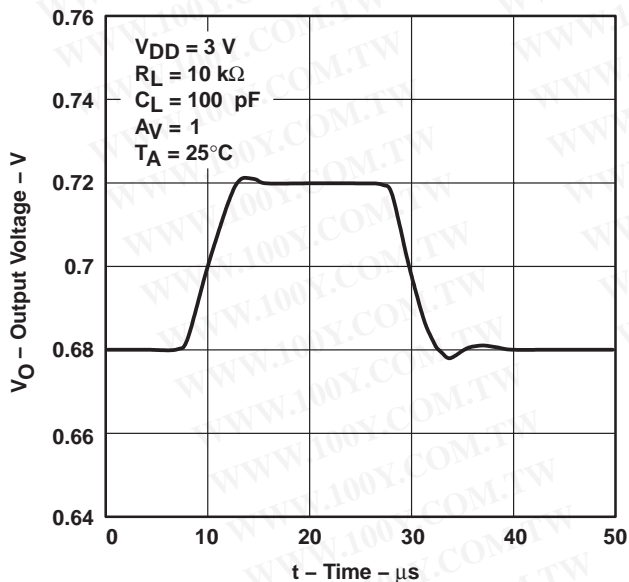
**Figure 41**

**INVERTING SMALL-SIGNAL PULSE RESPONSE†**



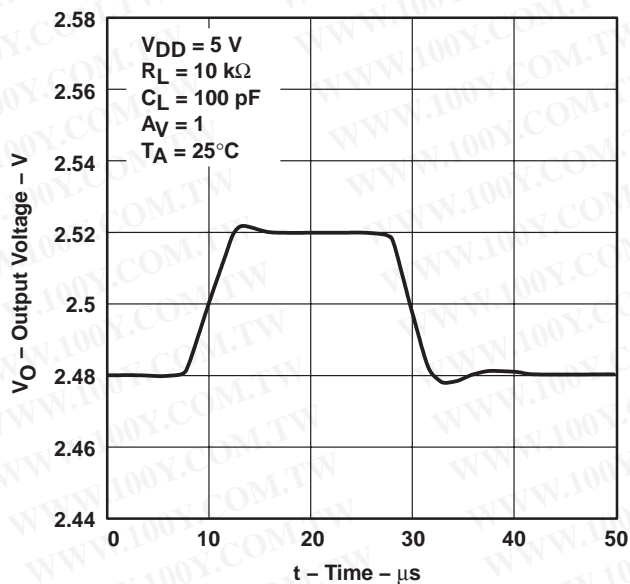
**Figure 42**

**VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE†**



**Figure 43**

**VOLTAGE-FOLLOWER SMALL-SIGNAL PULSE RESPONSE†**



**Figure 44**

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

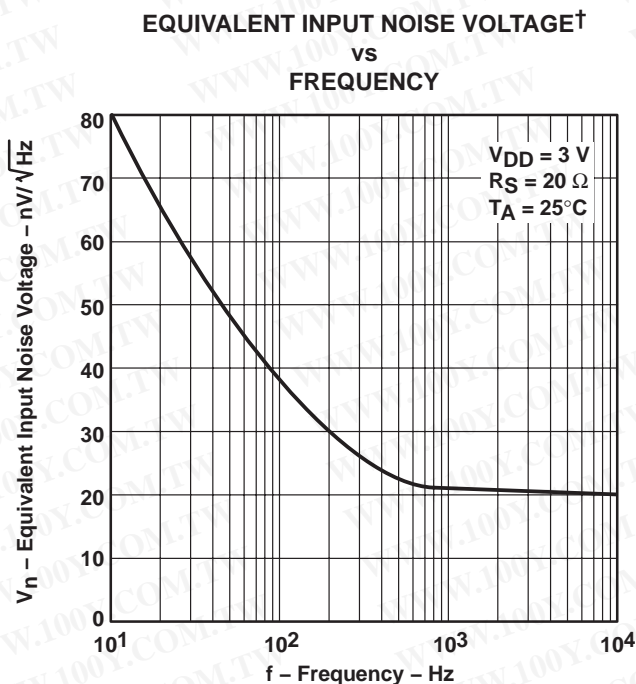


Figure 45

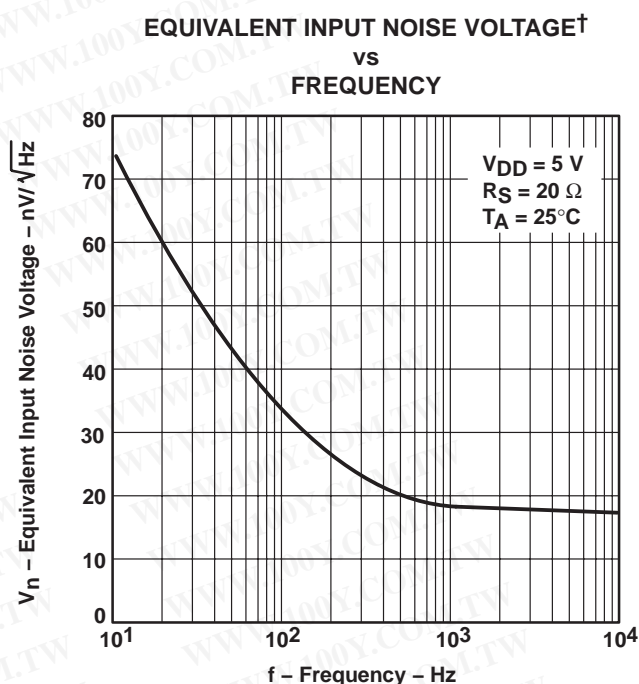


Figure 46

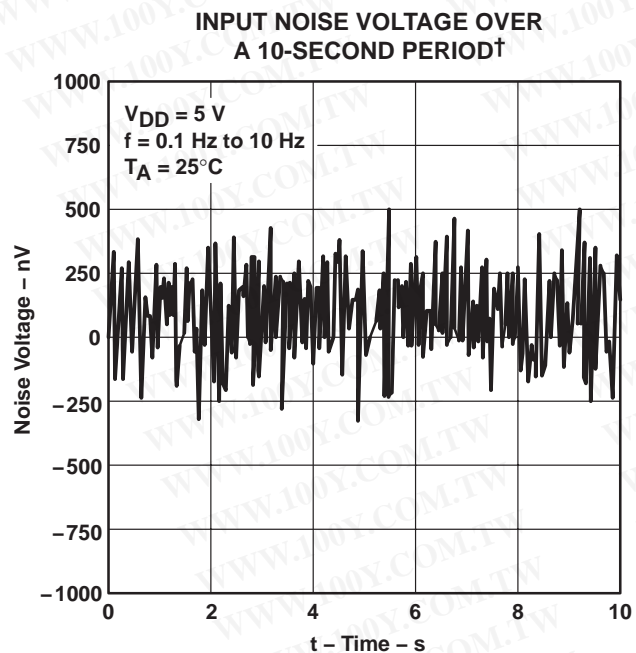


Figure 47

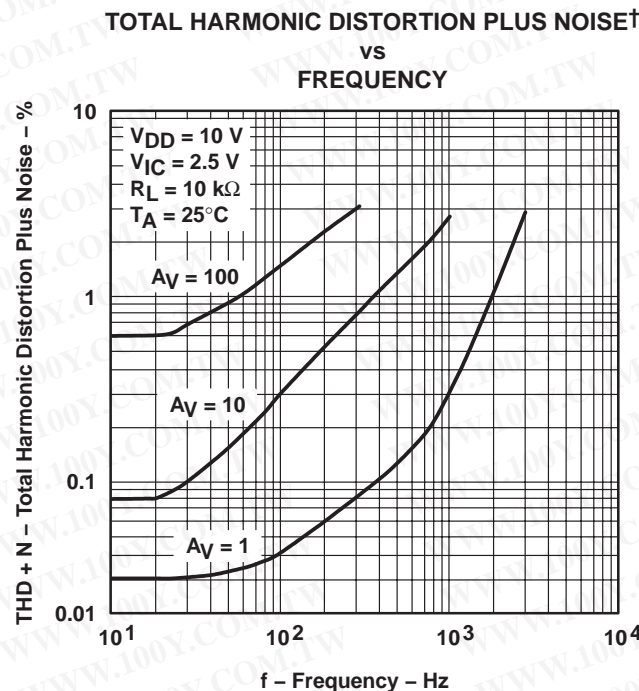
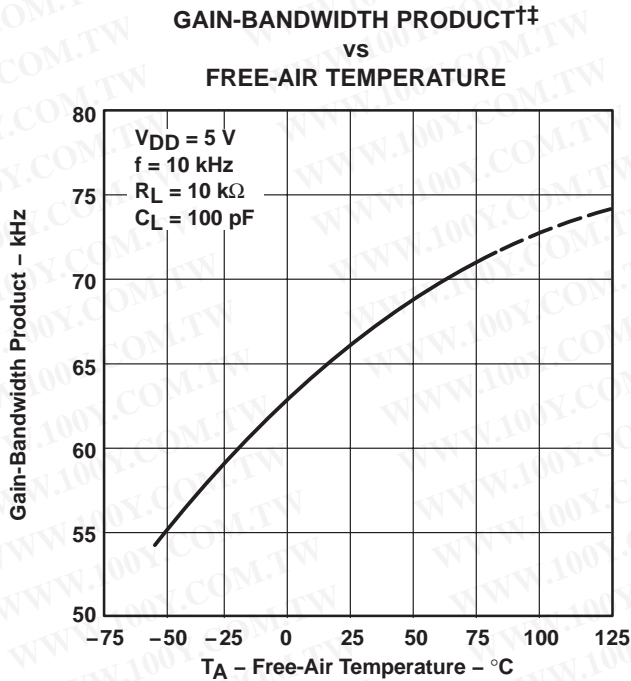


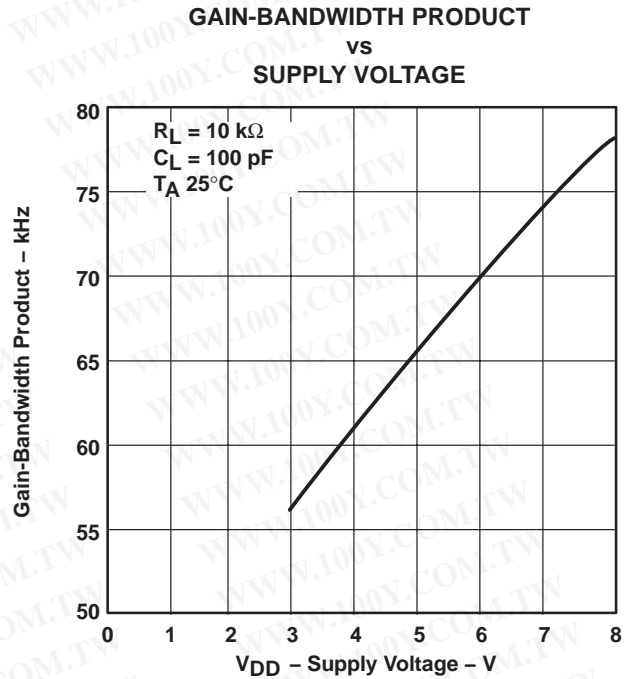
Figure 48

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

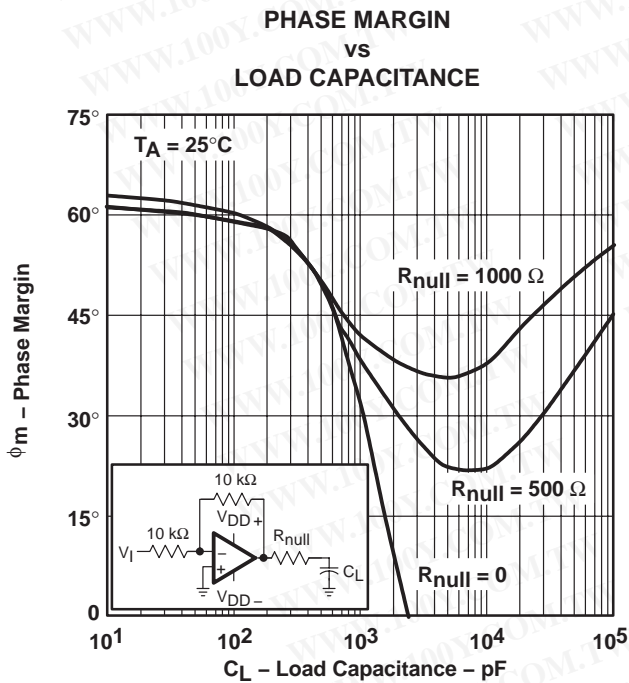
**TYPICAL CHARACTERISTICS**



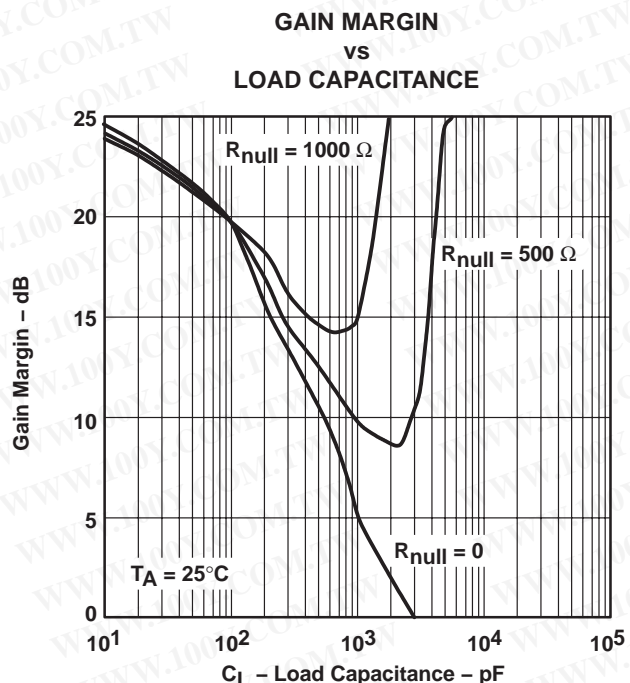
**Figure 49**



**Figure 50**



**Figure 51**



**Figure 52**

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.  
 ‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.



## TYPICAL CHARACTERISTICS

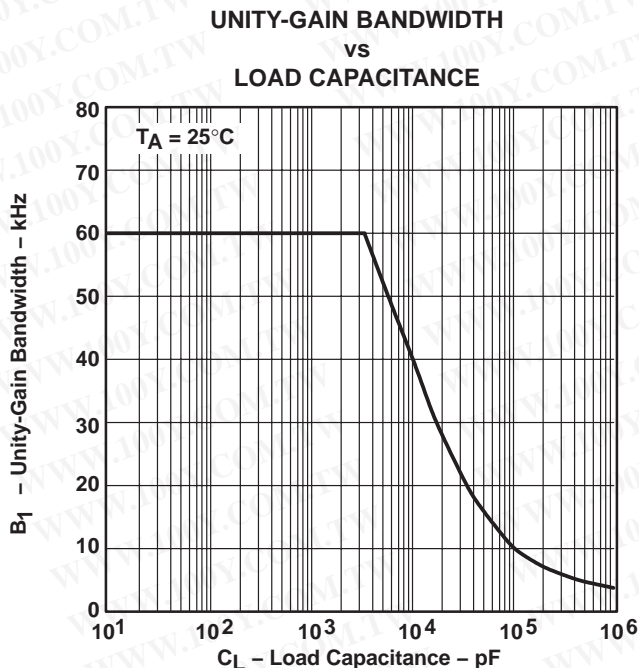


Figure 53

## APPLICATION INFORMATION

### driving large capacitive loads

The TLV2211 is designed to drive larger capacitive loads than most CMOS operational amplifiers. Figures 51 and 52 illustrate its ability to drive loads up to 600 pF while maintaining good gain and phase margins ( $R_{null} = 0$ ).

A smaller series resistor ( $R_{null}$ ) at the output of the device (see Figure 54) improves the gain and phase margins when driving large capacitive loads. Figures 51 and 52 show the effects of adding series resistances of 500  $\Omega$  and 1000  $\Omega$ . The addition of this series resistor has two effects: the first is that it adds a zero to the transfer function and the second is that it reduces the frequency of the pole associated with the output load in the transfer function.

The zero introduced to the transfer function is equal to the series resistance times the load capacitance. To calculate the improvement in phase margin, equation 1 can be used.

$$\Delta\phi_{m1} = \tan^{-1} \left( 2 \times \pi \times \text{UGBW} \times R_{null} \times C_L \right) \quad (1)$$

Where :

$\Delta\phi_{m1}$  = improvement in phase margin

UGBW = unity-gain bandwidth frequency

$R_{null}$  = output series resistance

$C_L$  = load capacitance

# TLV2211, TLV2211Y

## Advanced LinCMOS™ RAIL-TO-RAIL MICROPOWER SINGLE OPERATIONAL AMPLIFIERS

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### APPLICATION INFORMATION

#### driving large capacitive loads (continued)

The unity-gain bandwidth (UGBW) frequency decreases as the capacitive load increases (see Figure 54). To use equation 1, UGBW must be approximated from Figure 54.

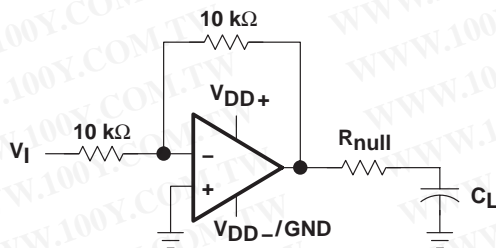


Figure 54. Series-Resistance Circuit

#### driving heavy dc loads

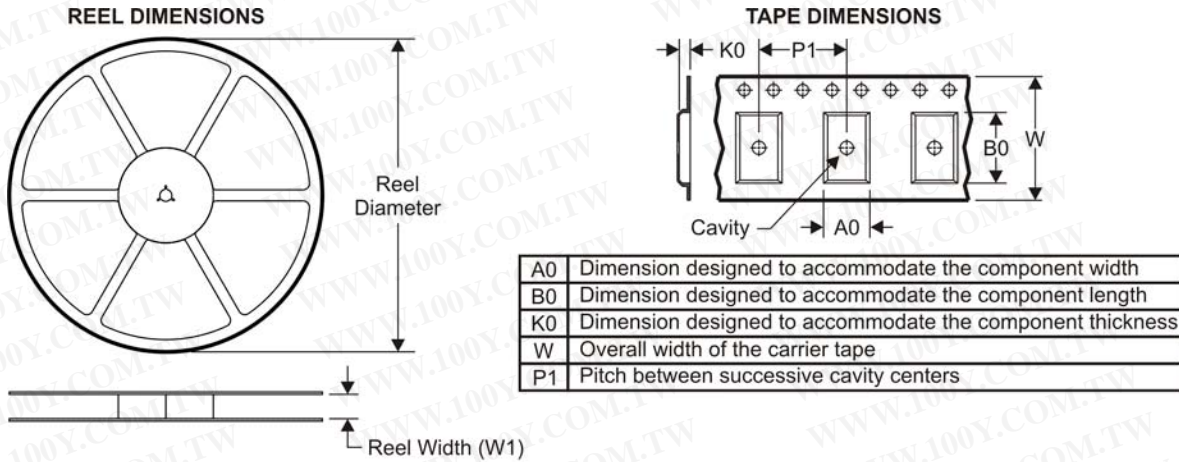
The TLV2211 is designed to provide better sinking and sourcing output currents than earlier CMOS rail-to-rail output devices. This device is specified to sink 500  $\mu\text{A}$  and source 250  $\mu\text{A}$  at  $V_{\text{DD}} = 3\text{ V}$  and  $V_{\text{DD}} = 5\text{ V}$  at a maximum quiescent  $I_{\text{DD}}$  of 25  $\mu\text{A}$ . This provides a greater than 90% power efficiency.

When driving heavy dc loads, such as 10 k $\Omega$ , the positive edge can experience some distortion under slewing conditions. This condition can be seen in Figure 39. This condition is affected by three factors:

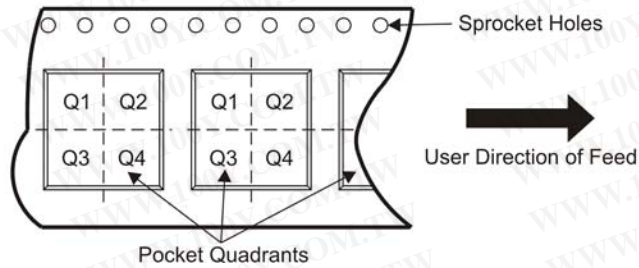
- Where the load is referenced. When the load is referenced to either rail, this condition does not occur. The distortion occurs only when the output signal swings through the point where the load is referenced. Figure 40 illustrates two 10-k $\Omega$  load conditions. The first load condition shows the distortion seen for a 10-k $\Omega$  load tied to 2.5 V. The third load condition shows no distortion for a 10-k $\Omega$  load tied to 0 V.
- Load resistance. As the load resistance increases, the distortion seen on the output decreases. Figure 40 illustrates the difference seen on the output for a 10-k $\Omega$  load and a 100-k $\Omega$  load with both tied to 2.5 V.
- Input signal edge rate. Faster input edge rates for a step input result in more distortion than with slower input edge rates.



**TAPE AND REEL INFORMATION**



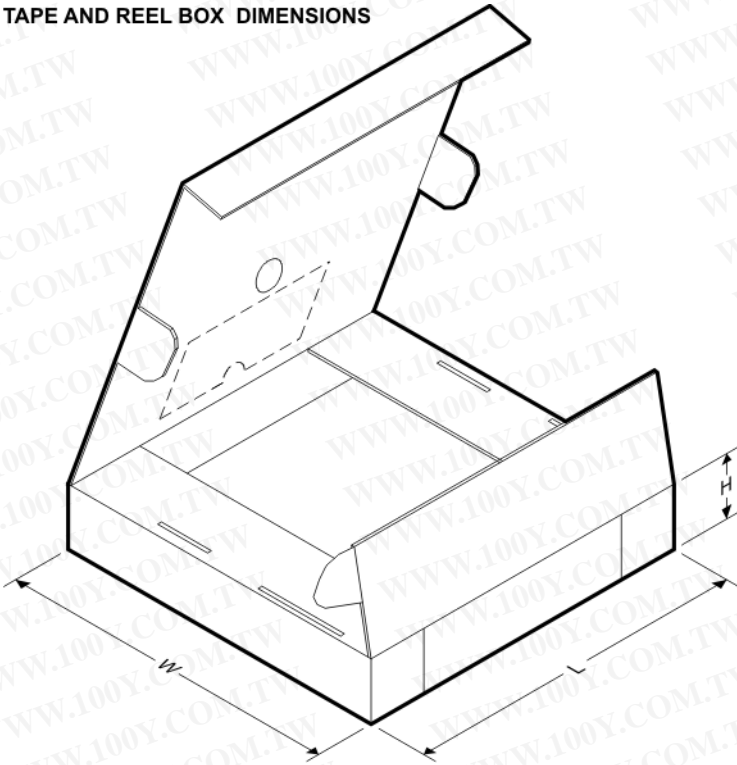
**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLV2211CDBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TLV2211CDBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TLV2211IDBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TLV2211IDBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3

**TAPE AND REEL BOX DIMENSIONS**

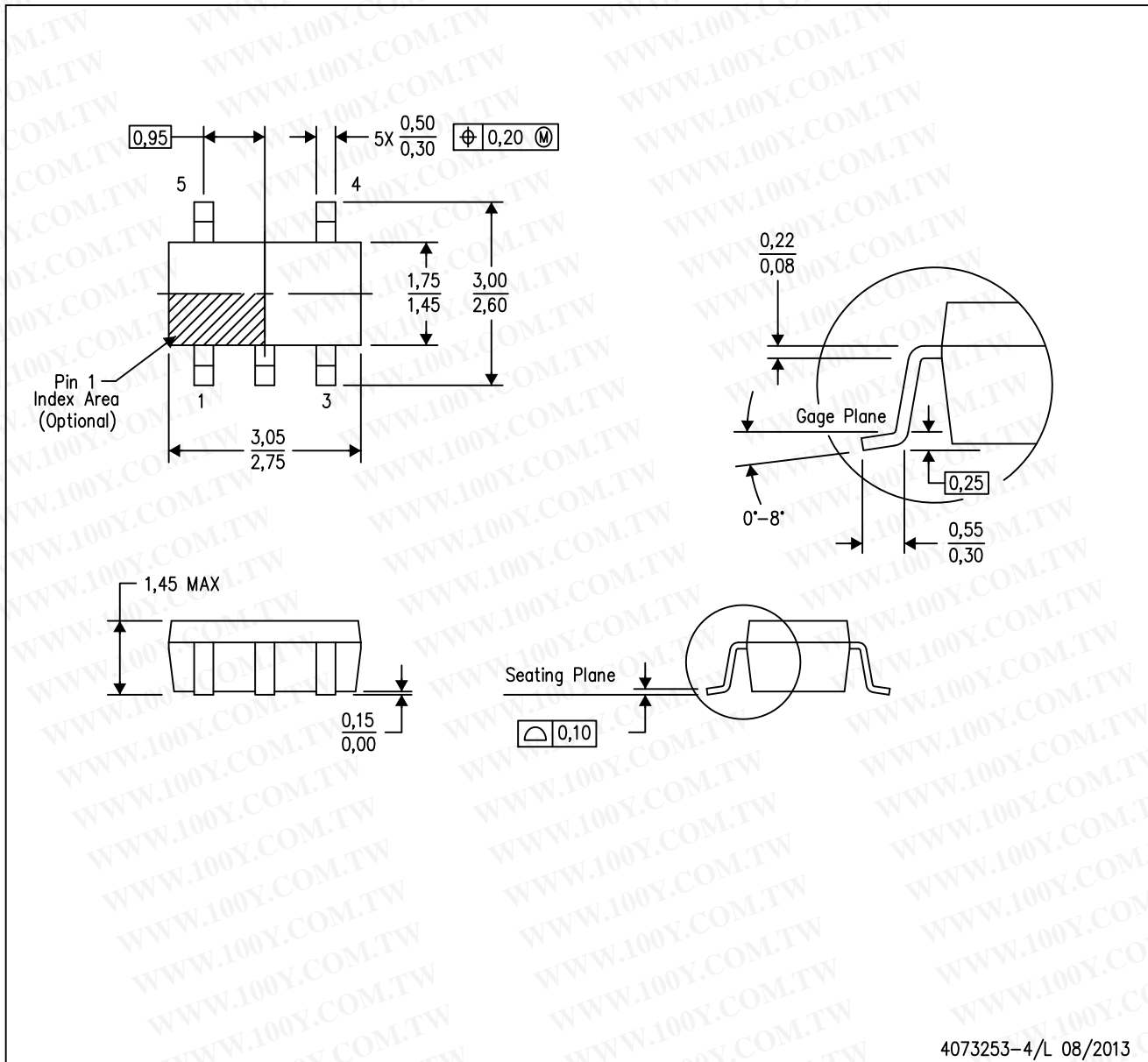


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLV2211CDBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TLV2211CDBVT	SOT-23	DBV	5	250	182.0	182.0	20.0
TLV2211IDBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TLV2211IDBVT	SOT-23	DBV	5	250	182.0	182.0	20.0

DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - Falls within JEDEC MO-178 Variation AA.

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